SONY. VIDEO GRAPHIC PRINTER UP-897MD

SERVICE MANUAL 1st Edition

△警告

このマニュアルは、サービス専用です。

お客様が,このマニュアルに記載された設置や保守,点検,修理などを行うと感電や火災, 人身事故につながることがあります。

危険をさけるため、サービストレーニングを受けた技術者のみご使用ください。

⚠ WARNING

This manual is intended for qualified service personnel only.

To reduce the risk of electric shock, fire or injury, do not perform any servicing other than that contained in the operating instructions unless you are qualified to do so. Refer all servicing to qualified service personnel.

MWARNUNG

Die Anleitung ist nur für qualifiziertes Fachpersonal bestimmt.

Alle Wartungsarbeiten dürfen nur von qualifiziertem Fachpersonal ausgeführt werden. Um die Gefahr eines elektrischen Schlages, Feuergefahr und Verletzungen zu vermeiden, sind bei Wartungsarbeiten strikt die Angaben in der Anleitung zu befolgen. Andere als die angegeben Wartungsarbeiten dürfen nur von Personen ausgeführt werden, die eine spezielle Befähigung dazu besitzen.

AVERTISSEMENT

Ce manual est destiné uniquement aux personnes compétentes en charge de l'entretien. Afin de réduire les risques de décharge électrique, d'incendie ou de blessure n'effectuer que les réparations indiquées dans le mode d'emploi à moins d'être qualifié pour en effectuer d'autres. Pour toute réparation faire appel à une personne compétente uniquement.

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Manual Structure

Purpose of this manual

This manual is the service manual of Video Graphic Printer UP-897MD. This manual describes the information on maintenance and the service information such as service overview, electrical alignment, circuit description, troubleshooting, and service mode (self-diagnosis function).

Related manuals

In addition to this "Service Manual", this unit is provided with the manual below.

 "Operating Instruction" PDF (Included in the CD-ROM Supplied for products.)

Part No.: 3-863-306-0X

These manuals describes the information required for the actual management and operation of this unit.

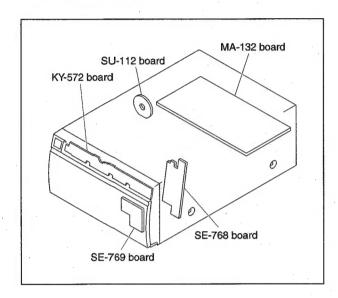
"Semiconductor Pin Assignments" CD-ROM (Available on request)
 This "Semiconductor Pin Assignments" CD-ROM allows you to search for semiconductors used in B&P Company equipment.

 Part number: 9-968-546-XX

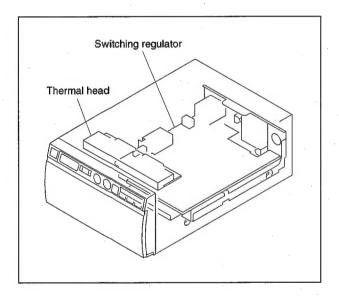


Section 1 Service Overview

1-1. Board Location



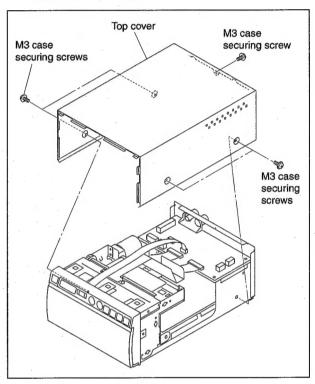
1-2. Main Parts Location



1-3. Removing/Installing the Cabinet

1-3-1. Top Cover

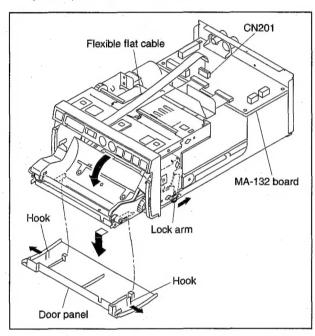
1. Remove the five M3 case securing screws, then remove the top cover.



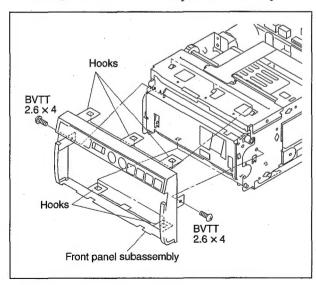
2. Attach the top cover in the reverse order.

1-3-2. Front Panel Subassembly

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Release the lock arm of the mechanical deck block (bottom surface) in the direction of the arrow, then open the door panel.
- 3. Remove the two hooks in both directions of the arrows.
- 4. Disconnect the flexible flat cable from the connector (CN201) on the MA-132 board.



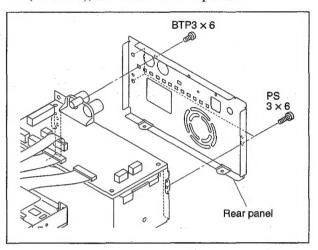
5. After closing the door, remove the two screws and five hooks, then remove the front panel subassembly.



6. Attach the front panel subassembly in the reverse order of steps 1 to 5.

1-3-3. Rear Panel

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the three screws (PS3 \times 6) and the screw (BTP3 \times 8), then remove the rear panel.



3. Attach the rear panel in the reverse order of steps 1 and 2.

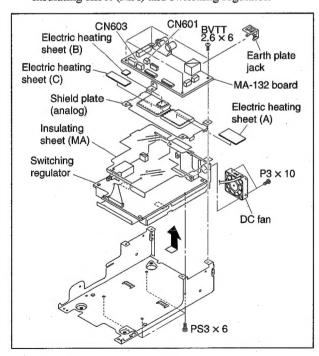
1-4. Replacing the Main Parts

1-4-1. Switching Regulator/DC Fan

Note

There are two types of DC fan mounting connectors. Connect the harness of the DC fan for power supply to the connector (CN601). The connector (CN603) is provided for mounting the optional DC fan for cooling the thermal head.

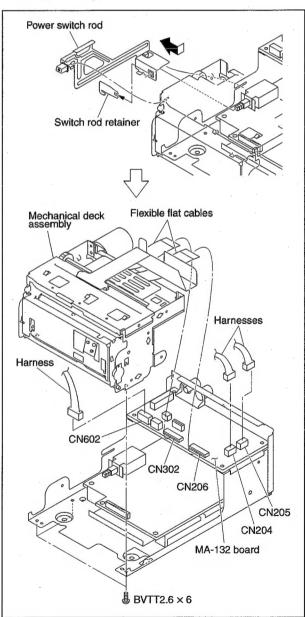
- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel subassembly. (Refer to Section 1-3-2.)
- 3. Remove the rear panel assembly. (Refer to Section 1-3-3.)
- 4. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- 5. Disconnect all harnesses and flexible flat cables from the MA-132 board.
- 6. Remove the four screws (BVTT2.6 × 6), then remove the MA-132 board, shield plate (analog) and earth plate jack.
- 7. Remove the electric heating sheet (A), electric heating sheet (B) and electric heating sheet (C) from the shield plate (analog).
- 8. Remove the two screws (P3 \times 10), then remove the DC fan.
- 9. Remove the four screws (PS3 × 6), then remove the insulating sheet (MA) and switching regulator.



10. Attach the switching regulator in the reverse order of steps 1 to 9. $$\sf UP-897MD$$

1-4-2. Mechanical Deck Assembly

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel subassembly. (Refer to Section 1-3-2.)
- 3. Remove the switch rod retainer, then remove the power switch rod.
- Disconnect the three harnesses from the connectors (CN204, CN205 and CN602) on the MA-132 board.
- Disconnect the two flexible flat cables from the connectors (CN206 and CN302) on the MA-132 board.
- Remove the three screws, then remove the mechanical deck assembly.



7. Attach the mechanical deck assembly in the reverse order of steps 1 to 6.

1-4-3. Thermal Head

Note

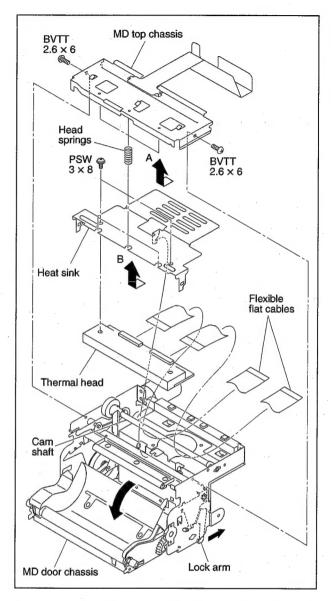
After replacing the thermal head, perform the head voltage adjustment. For the adjustment procedure, refer to Section 2-4.

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel assembly. (Refer to Section 1-3-2.)
- 3. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- Remove the two screws (BVTT2.6 × 6), then remove the MD top chassis and three head springs.

Note

When removing the MD top chassis, be sure to remove it slowly in the direction of the arrow A to prevent the head springs from popping out.

- 5. Release the lock arm in the direction of the arrow, then open the MD door chassis.
- 6. Remove the heat sink in the direction of the arrow B.
- 7. Remove the two screws (PSW3 × 8), then remove the thermal head.
- Disconnect the two flexible flat cables from the thermal head.



9. Attach the thermal head in the reverse order of steps 1 to 8.

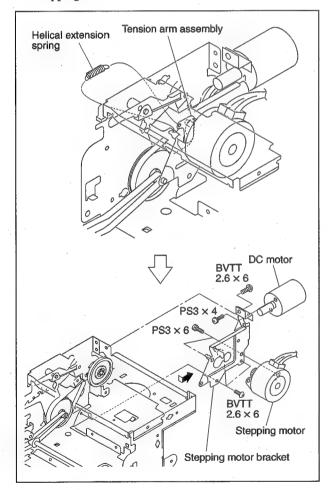
Note

When connecting the flexible flat cables, route them under the cam shaft.

1-4-4. Stepping Motor/DC Motor

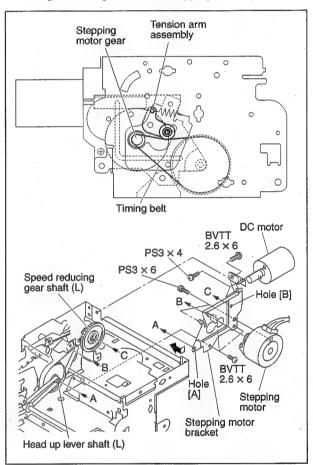
Removal

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel assembly. (Refer to Section 1-3-2.)
- 3. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- 4. Remove the helical extension spring from the tension arm assembly.
- 5. Remove the four screws (BVTT2.6 × 6), then remove the stepping motor bracket.
- 6. Remove the two screws (PS3 × 4), then remove the DC motor.
- 7. Remove the two screws (PS3 × 6), then remove the stepping motor.



Installation

- 8. Attach the DC motor with the two screws.
- Insert the head up lever shaft (L) into the hole [A] and insert the speed reducing gear shaft (L) into the hole [B], then attach with the three screws.
- 10. Hang the timing belt on the stepping motor gear.

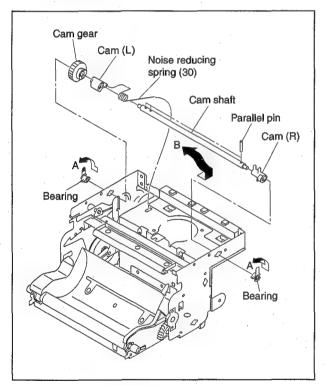


11. Assemble this unit in the reverse order of steps 1 to 4.

1-4-5. Cam Shaft Assembly

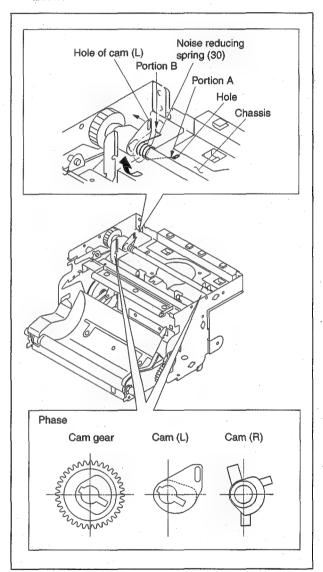
Removai

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel assembly. (Refer to Section 1-3-2.)
- 3. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- 4. Remove the thermal head. (Refer to Section 1-4-3.)
- 5. Remove the paper holder assembly. (Refer to step 4 of Section 1-4-7.)
- 6. Remove the two bearings by rotating them in the direction of the arrows A.
- 7. Remove the cam shaft assembly in the direction of the arrow B.
- Remove the cam (R), cam gear, cam (L), noise reducing spring (30) and three parallel pins from the cam shaft.



Installation

- 9. Attach the cam shaft assembly in the reverse order of steps 6 to 8.
- 10. Insert the portion A of noise reducing spring (30) into the hole of chassis, then insert the portion B into the hole of cam (L) by rotating it in the direction of the arrow.



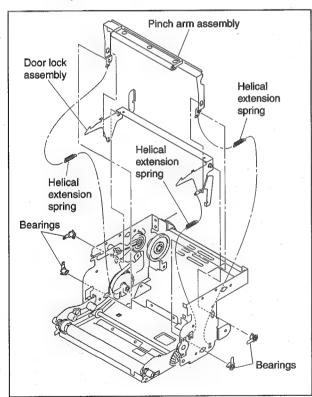
11. Assemble this unit in the reverse order of steps 1 to 5.

1-4-6. Pinch Arm Assembly

Note

When replacing the pinch arm subassembly, be extremely careful not to touch it with bare hands or dirty gloves. If the pinch arm subassembly is contaminated, clean it with the ethyl alcohol.

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel assembly. (Refer to Section 1-3-2.)
- 3. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- 4. Remove the thermal head. (Refer to Section 1-4-3.)
- 5. Remove the paper holder assembly. (Refer to step 4 of Section 1-4-7.)
- 6. Remove the three helical extension springs.
- Remove the four bearings, then remove the door lock assembly and pinch arm assembly in the direction of the arrow.
- 8. Remove the pinch arm assembly from the door lock assembly.



9. Attach the pinch arm assembly in the reverse order of steps 1 to 8.

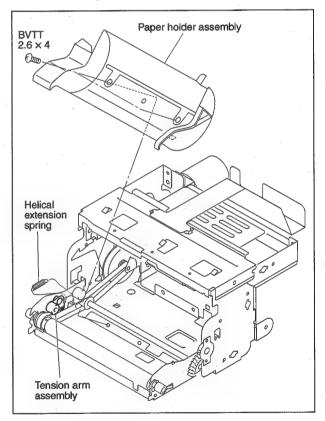
After attaching the pinch arm assembly, clean it with alcohol.

1-4-7. Platen Roller

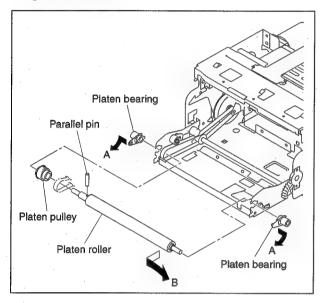
Note

When replacing the platen roller, be extremely careful not to touch it with bare hands or dirty gloves. If the roller is contaminated, clean it with the ethyl alcohol.

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel assembly. (Refer to Section 1-3-2.)
- 3. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- 4. Remove the two screws, then remove the paper holder assembly.
- 5. Remove the helical extension spring from the tension arm assembly.



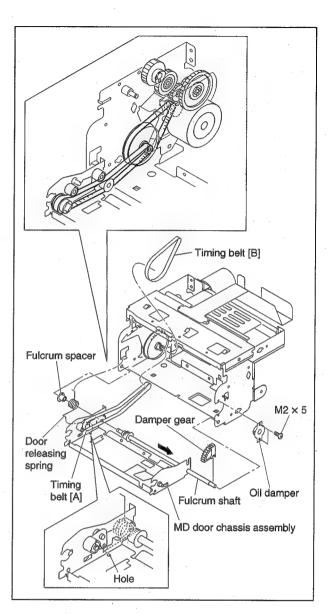
- 6. Remove the two platen bearings by rotating them in the direction of the arrow A.
- 7. Remove the platen roller in the direction shown by the arrow B.
- 8. Remove the platen pulley and parallel pin from the platen roller.



9. Attach the platen roller in the reverse order of steps 1 to 8.

1-4-8. Timing Belt

- 1. Remove the top cover. (Refer to Section 1-3-1.)
- 2. Remove the front panel assembly. (Refer to Section 1-3-2.)
- 3. Remove the mechanical deck assembly. (Refer to Section 1-4-2.)
- 4. Remove the paper holder assembly. (Refer to step 4 of Section 1-4-7.)
- 5. Remove the two screws, then remove the oil damper.
- 6. Remove the damper gear.
- 7. Remove the door releasing spring from the hole of MD door chassis, then remove the MD door chassis assembly.
- 8. Remove the fulcrum spacer, then remove the door releasing spring.
- 9. Pull out the fulcrum shaft from the MD door chassis assembly in the direction of the arrow.
- 10. Remove the timing belt [A] and timing belt [B].



11. Attach the timing belt [A] and timing belt [B] in the reverse order of steps 1 to 10.

Procedure Required for Replacement

When replacing the following parts, perform each required process according to the table below. For the procedure before and after performing the required process, refer to Section 2-1.

Parts	Required process	Reference
MA-132 board	Firmware Version Upgrade	Section 2-6
IC103 (MA-132 board)		
KY-572 board	Calibration and Electrical Conductivity Check	Section 2-2
Switching regulator	Head Voltage Adjustment	Section 2-4
Thermal head		

Unleaded Solder

Boards requiring use of unleaded solder are printed with a lead free mark (LF) indicating the solder contains no lead.

(Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size.)



: LEAD FREE MARK

Notes

- · Be sure to use the unleaded solder for the printed circuit board printed with the lead free mark.
- The unleaded solder melts at a temperature about 40 °C higher than the ordinary solder, therefore, it is recommended to use the soldering iron having a temperature regulator.
- · The ordinary soldering iron can be used but the iron tip has to be applied to the solder joint for a slightly longer time. The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful.



Section 2 Electrical Alignment

2-1. Procedure before and after Adjustment

Print out the record of user setting before performing the board replacement and adjustment. For the procedure of printing out the record, refer to Section 2-1-1.

If the history record of user setting cannot be printed due to the failure of this unit, reset the unit to the factory setting after performing the board replacement and adjustment. (Refer to Section 2-1-3.)

2-1-1. Procedure of Printing the User Setting Record (Before Adjustment)

Print out the top menu record of setting (last setting) and the list of all setting in the following procedure. After completing the board replacement and adjustment, if the setting is different from the contents of record printed before adjustment, adjust the setting so that it becomes the same as the setting before adjustment. Complete the procedure by adjusting the setting to the contents of top menu record.

Procedure

- Turn on the POWER. "READY" is displayed on LCD of this unit.
- 2. Press the OPEN button to open the door panel.
- 3. Set the thermal paper and close the door panel.
- 4. Press the jog dial.
- 5. Print out the record of the top menu (last setting) displayed on LCD.
- 6. Rotate the jog dial to display "MENU" on LCD, then press the jog dial.

All settings are printed on the thermal paper.

Note

Be sure to keep the printed sheets (user setting) because they are used as the reference to check the setting after adjustment.

2-1-2. User Setting Check Procedure (After Adjustment)

After completing the adjustment, reset this unit to the user setting in the following procedure.

Procedure

- 1. Print out the setting of this unit. (Refer to steps 1 to 6 of Section 2-1-1.)
- 2. Compare the setting list printed in step 1 with the setting list (used as reference) printed in step 6 of Section 2-1-1.

Note

If there is any difference between the settings, adjust to the reference setting using the jog dial. If there is no difference, press the jog dial.

(Setting is completed.)

- After adjusting the setting to the reference setting, press the jog dial.
 - The adjusted setting is displayed on LCD.
- 4. Check that the contents of setting are correct, then press the jog dial.

2-1-3. Factory Setting

Procedure

1. Turn on the POWER while pressing the OPEN button.

Note

The beep sound is made immediately after turning on the POWER and after that again.

2. Release the OPEN button, then press the PRINT button.

Note

Press the PRINT button within 3 seconds after the second beep sound in step 1 is made.

- 3. Check that this unit becomes the following state.
 - (Change to the factory setting)
 - (1) Backlight is off.
 - (2) Backlight lights in green.
 - (3) Backlight lights in red.
 - (4) Flashes two times automatically.
 - (5) Beep sound is made.

2-2. Calibration and Electrical Conductivity Check

After replacing the KY-572 or MA-132 board, perform the calibration of brightness and contrast volumes, and perform the electrical conductivity check of each button.

 Turn on the power while pressing the PRINT button and COPY button simultaneously.
 The service mode starts.

Note

Do not release the PRINT button and COPY button before the beep sound is made.

- Press the jog dial two times. "SVC" and then "PATAN" are displayed on LCD in order.
- 3. Rotate the jog dial to display "BR:CAL".
- 4. Press the jog dial.

The calibration mode of brightness starts.

- (1) Rotate the BRIGHT volume fully to the left in the state that "BR:LEF" is displayed on LCD, then press the jog dial.
- (2) Rotate the jog dial to display "BR:RIG" and rotate the BRIGHT volume fully to the right in the state that "BR:RIG" is displayed on LCD, then press the jog dial.
- (3) Rotate the jog dial to display "BR:CEN" and return the BRIGHT volume to the center in the state that "BR:CEN" is displayed on LCD, then press the jog dial.
- 5. Rotate the jog dial to display "BACK", then press the jog dial.
- 6. Rotate the jog dial to display "CO:CAL".
- 7. Press the jog dial.

The calibration mode of contrast starts.

- (1) Rotate the CONT volume fully to the left in the state that "CO:LEF" is displayed on LCD, then press the jog dial.
- (2) Rotate the jog dial to display "CO:RIG" and rotate the CONT volume fully to the right in the state that "CO:RIG" is displayed on LCD, then press the jog dial.
- (3) Rotate the jog dial to display "CO:CEN" and return the CONT volume to the center in the state that "CO:CEN" is displayed on LCD, then press the jog dial.

8. Check the electrical conductivity of the FEED button.

Press the FEED button.

The error beep sound is made.

Note

The electrical conductivity of other buttons can be checked by calibration.

Check the electrical conductivity of the OPEN button.

Press the OPEN button.

The front door is opened.

10. Turn off the power.

2-3. Brightness and Contrast Adjustment

After replacing the MA-132 board, perform the following adjustment procedure.

Required equipment

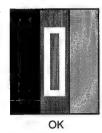
- Monitor
- · Digital voltmeter
- 10 step signal generator (Equivalent to Tektronix 1410 (NTSC signal))

Connection

- Input signal: 10 step signal
- · Connect this unit and the monitor.

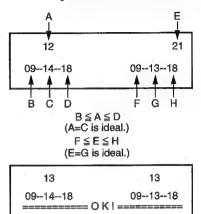
Procedure

- 1. Reset this unit to the factory setting. (Refer to Section 2-1-3.)
- Rotate the jog dial to display "VOLME" on LCD, and then press the OPEN button.
 The adjustment mode starts.
- 3. Check that the CONTRAST volume and BRIGHT volume are displayed at the center.





 An oblong-shaped frame is displayed almost at the center of each step. 5. Adjust with ©RV503 and ©RV504 while checking the monitor until the specification is satisfied.



6. Check that "OK" is displayed at the bottom of the screen.

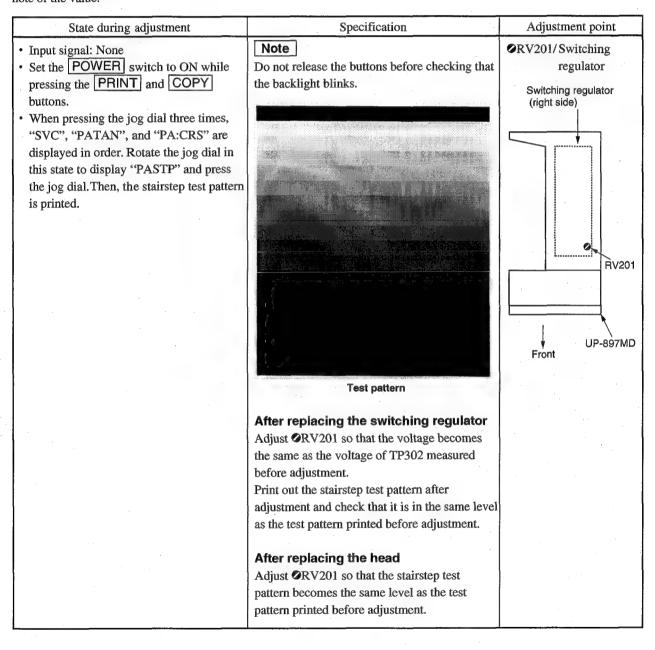
2-4. Head Voltage Adjustment

After replacing the thermal head or the switching regulator, perform this adjustment.

Note

Before starting the replacement, print out the stairstep test pattern which is used as the reference of adjustment.

Before replacing the switching regulator, measure the voltage of TP302 on the MA-132 board and take a note of the value.



2-5. Initialization of Print Count History

After replacing the thermal head, perform the initialization of print count history.

State during adjustment	Specification	Adjustment point
Input signal: None		None
• Set the POWER switch to ON while		
pressing the PRINT and COPY buttons.		
When pressing the jog dial two times,		
"SVC" and "PATAN" are displayed in	en e	
order. Rotate the jog dial in this state to		
display "RESET" and press the jog dial. "R:MENU" is displayed and rotate the	Check that "RESET" is displayed.	
jog dial. After displaying the "R:H.PRN",	The initialization of print count history is	
then press the jog dial.	completed (count becomes "0").	

2-6. Firmware Version Upgrade

After replacing the MA-132 board or IC103 on the MA-132 board, be sure to perform the firmware version upgrade.

Note

Never turn off the power during the firmware version upgrade.

Required equipment

 Personal computer (hereafter referred to as PC) (USB interface is mounted.)

OS: Windows 2000/XP

Driver: Driver software of UP-D897 is installed.

· Utility software for version upgrade

Note

Download the adjustment utility software from the URL described in the technical memo.

Latest firmware

Note

Download the latest firmware from the GSP homepage or from the URL described in the technical memo.

· USB cable

Note

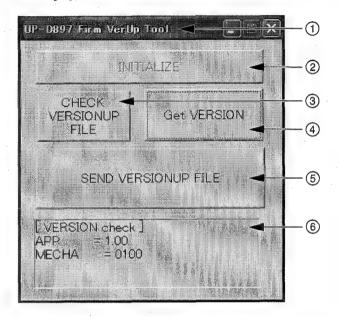
Use the cable of A-minB connector.

Preparation

- Remove the USB plate of the rear panel of this unit, then connect this unit and PC using the USB cable.
- 2. Turn on the power of this unit and PC.
- 3. Install the driver software in PC. (Only when it is not installed.)
- 4. Copy the latest firmware to the directory same as the version upgrade utility.

Version upgrade

Start the version upgrade utility software.
 The version upgrade utility software screen is displayed.



Number	Description	
1	Model name to be upgraded	
2	Search for the version upgrade model	
3	Check of version upgrade file information	
4	Check of firmware version written in this unit	
⑤	Write the firmware in IC103 on the MA-132 board.	
6	Status display window	

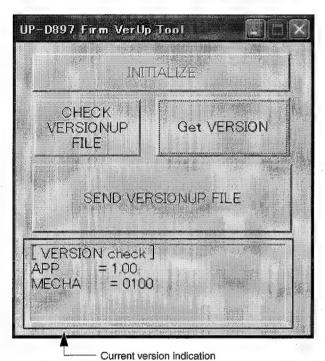
2. Click the INITIALIZE button.

Note

In the case that the version upgrade utility software for the version upgrade of this unit is installed, the CHECK VERSIONUP FILE and Get VERSION buttons are enabled. In case that the cable is not connected or the version upgrade utility software for the version upgrade of this unit is not installed, the CHECK VERSIONUP FILE and Get VERSION buttons are disabled in gray out state.

When the CHECK VERSIONUP FILE and Get VERSION buttons are in gray out state, check the connection of PC and this unit, or the version upgrade utility software.

Click the Get VERSION button.
 The installed firmware version is displayed.



- 4. Check or take a note of the version displayed in step 3.
- Click the CHECK VERSIONUP FILE button. The VUP file information is displayed on another window.
- Check the version and date to make sure that the downloaded firmware is the latest version.
- 7. Click the SEND VERSIONUP FILE button.

 The writing of firmware starts.

Note

When the writing starts, the LED backlight changes from staying lit to blinking, the beep sound is made. After this, the writing is completed when the backlight changes from blinking to staying lit.

- 8. Check that the writing is completed, and then turn the power of this unit off and on again (restart).
- 9. Start the version upgrade utility software.
- 10. Click the INITIALIZE button.
- 11. Click the Get VERSION button.
- 12. Make sure that the firmware is the latest version on the utility screen.
- 13. Exit the version upgrade utility software.

Procedure after completion of version upgrade

1. Turn off the power of this unit and PC, and then disconnect the USB cable.



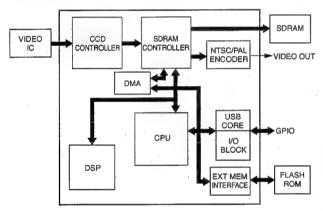
Section 3 Circuit Description

3-1. System Control Block

3-1-1. Outline

System control is performed using IC104 (TMS320DM310ZHK22) on the MA-132 board. The system control block consists of the following blocks.

- CPU block (ARM925)
- · SDRAM control block
- · External memory control block (Flash memory, etc.)
- DSP block (Image processing)
- External interface block (USB1.0, memory cards, video encoder, and CCD interface)



Block diagram of IC104

3-1-2. Block Diagram of Electrical Block

Refer to "Section 6 Block Diagram".

3-2. Head/Mechanical Control Block

3-2-1. Outline

The thermal head/mechanical control block is the circuit block of IC202 (CXD9182AGG) on the MA-132 board. There is an external I/O block except the thermal head/mechanical control block.

3-2-2. Platen Motor Control

A platen driving stepping motor controls the forward rotation/reverse rotation and rotation speed when IC202 controls driving transistors (Q603 to Q606).

IC202	Signal name	State			
Pin 46	PM_A1	L	L	Н	Н
Pin 47	PM_A2	Н	Н	L	L
Pin 92	PM_B1	L	Н	Н	L
Pin 93	PM_B2	Н	L	L	Н
			Forward i	otation	
			Reverse i	rotation	

3-2-3. Thermal Head UP/DOWN Control

A thermal head UP/DOWN DC motor is driven using a driving circuit (IC201 on the SE-768 board). The DC motor can be rotated in the forward and reverse directions. It is controlled by IC202. Two types of optical position sensors (photo-interrupters PH201 and PH203 on the SE-768 board) detect the DC motor position and IC202 reads it.

Operation of Head UP/DOWN Motor

DC motor	IC202 (pin 1) or CN204 (pin 8) DCM_0	IC202 (pin 2) or CN204 (pin 7) DCM_1	Operation
Forward rotation	L	Н	The thermal head is raised.
Reverse rotation	Н	L	The thermal head is lowered.
Brake	Н	Н	Stop
Stop	L	: L	Stop

State of position sensor

Position	IC202 (pin 53) or CN204 (pin 3) HEAD_P_SENSE	IC202 (pin 96) or CN204 (pin 5) HEAD_P2_SENSE	State
PRINTING	L '	Н	Printing
HOME	Н	L	Standby (Usually)
DOOR OPEN	Н	Н	Door unlocked

3-2-4. Monitoring of Door Sensor

The door position is read using an optical door position sensor (photo-interrupter PH202 on the SE-768 board) by IC202.

State of door position sensor

Position	IC202 (pin 87) or CN204 (pin 2) DOOR_SENSE	State
CLOSE	Н	The door is closed.
OPEN	L	The door is opened.

3-2-5. Monitoring of Paper Sensor

Whether thermosensible paper is correctly set in this unit is detected using two pairs of optical paper sensors (phototransistors Q102 and Q302 on the KY-572 and SE-769 boards) and read using IC202.

State of paper sensor

IC202 (pin 43) or CN201 (pin 7) AI (PAPER_SENSE	03 CN205 (pin 2) AD5	State
Н	Н	Paper
L	L	No paper
Н	L.	No paper (Paper exists in an eject port and does not exist in a tray.)
. L	Н	No paper (Paper does not exist in an eject port and exists in a tray.)

3-2-6. Monitoring of Head Temperature Sensor

The change in the resistance value of a thermistor in a thermal head is converted into a voltage and read using IC202. The A/D-converted voltage value corrects the density (gamma), controls the head cooling fan motor, and discriminates whether to clean the head.

3-2-7. Control of Head Fan Motor (for Head Cooling)

A head fan motor operates when IC202 controls driving transistors (Q607 and Q608). The head fan motor is turned on when the head temperature is more than approximately 62°C (cooling) or during printing.

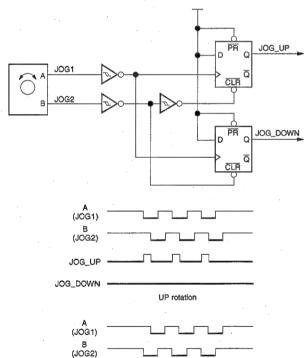
Operation of head fan motor

IC202 (pin 94) HEAD_FAN	Operation
L	OFF
Н	ON

3-2-8. Read of Buttons

The PRINT, OPEN, COPY, FEED, and jog dial buttons on the front panel and the REMOTE button on the rear panel are monitored. Each button (not including jog dial buttons UP and DOWN) is shifted to operation after the falling of a signal is detected. Jog dial buttons UP and DOWN are shifted to operation after the rising of a signal is detected.

IC202	Signal name	Function
Pin 7	KEY1	OPEN
Pin 98	KEY2	PRINT
Pin 55	KEY3	COPY
Pin 133	KEY4	FEED
Pin 6	JOG3	ENTER
Pin 54	JOG_UP	Rotates the jog dial upward.
Pin 97	JOG DOWN	Rotates the iog dial downward.



DOWN rotation

Video Circuit Block

3-3-1. Outline

A composite video signal is input from the BNC connector (VIDEO IN) to the MA-132 board. 75 Ω termination is turned on and off using a slide switch on the rear panel. After that, a signal is input to a video circuit (IC501) for sync separation, low-pass filter processing, brightness/ contrast, and AGC processing. The output signal is input to an A/D converter. The digitized signal is read to a system control block.

3-3-2. Control of Video Circuit Block

A chroma trap filter, low-pass filter, and AGC are turned on and off, and NTSC/PAL and THR/EE are switched using a general-purpose port of IC202, respectively.

IC202	Signal name	Function
Pin 29	TH/EE_OUT	Switches TH/EE. H: EE L: TH
Pin 76	NTSC/PAL_SW	Switches NTSC/PAL. H: NTSC L: PAL
Pin 31	AGC_SW	Turns on and off AGC. H: ON L: OFF
Pin 30	LPF_SW	Turns on and off the low-pass filter. H: ON L: OFF
Pin 115	TRAP_SW	Turns on and off the trap filter. H: ON L: OFF

3-3-3. Control of Brightness and Contrast

Brightness and contrast are controlled by inputting the voltage, obtained using a volume control on the front panel, to IC501 (BRIGHT: pin 38, CONTRAST: pin 39). The gain of an internal video amplifier then changes and can be adjusted.

JOG_UP

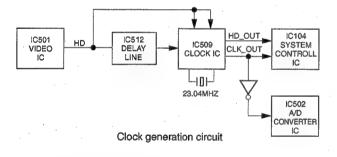
JOG_DOWN

3-3-4. A/D and D/A Conversion

The video signal output from a video circuit (IC501) is converted into a digital signal using an A/D converter and transferred to memory using a system control circuit (IC104). The A/D-converted data is D/A-converted using a video encoder in the system control circuit (IC104) and input to a video circuit (IC501). After that, the data is output to the BNC connector via the selector switch in a video circuit. In ordinary EE, instead of this path, data is looped in a video circuit and output via the selector switch described above. Data is output from a system control circuit in the case of the scale change for which a video signal is processed.

3-3-5. Clock Generation Circuit Block

A clock of 23.04 MHz is generated as the sampling clock of a video signal using a clock circuit (IC509). The phase of the clock generated using this clock circuit is adjusted to the phase at the falling edge of an HD pulse (horizontal sync pulse) during image read operation. The read position can be always made constant when the phase relation between the HD pulse and clock is compensated.



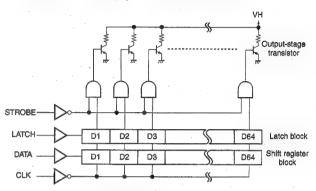
3-4. USB Interface

There is a USB1.0 interface (mini B connector) for firmware rewrite operation. The USB1.0 interface is controlled by IC104 (TMS320DM310ZHK22). Refer to "2-6. Firmware Version Upgrade" for how to rewrite firmware.

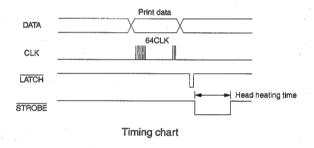
3-5. Thermal Head Block

3-5-1. Structure

A thermal head consists of 1280 dots (64 bits \times 20) per line. There are twenty pairs of blocks below.



Internal circuit configuration of thermal head (corresponding to one port)



3-5-2. Basic Operation

Each signal is input from IC202 to the thermal head for operations below.

- (1) Print data is input to the shift register block in synchronization with a CLK pulse. (64-bit data)
- (2) The data input in step (1) is moved from the shift register block to the latch block when a latch pulse is input.
- (3) When a STB pulse is input, the "H" and "L" data of a latch block turn on and off an output-stage transistor and a resistor is heated for the color development of thermosensible paper.

3-5-3. Temperature Correction

The print energy required for thermosensible paper changes moment by moment due to the heating and thermal storage of a thermal head during change in room temperature or continuous printing. Therefore, the corresponding correction is required. In this unit, IC202 measures the temperature change of a thermal head from the internal thermistor of the thermal head. IC202 then converts the temperature change into 8-bit head temperature data and corrects the change in concentration for the temperature on which gamma characteristics were reflected. The concentration change can be corrected by controlling the width of a STB pulse.

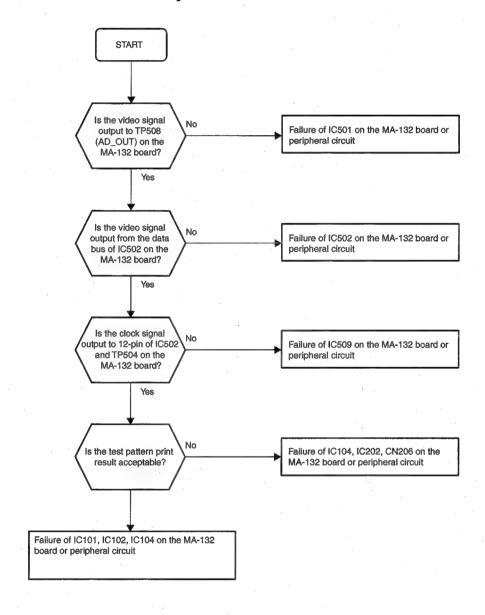
3-5-4. Correction of Resistor Count

The total current flowing through a thermal head differs in the state where the resistors of the thermal head are all turn on or partially turned on. Therefore, an error occurs in the energy applied to each resistor. When print is made without correcting an error, a stripe occurs in the print result at the point where the number of resistors in which a thermal head is turned on changes rapidly. A circuit that corrects this stripe is incorporated into IC202.

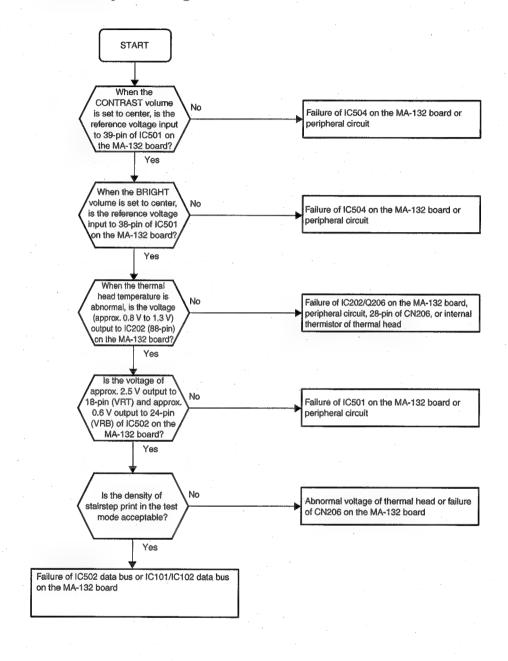


Section 4 Troubleshooting

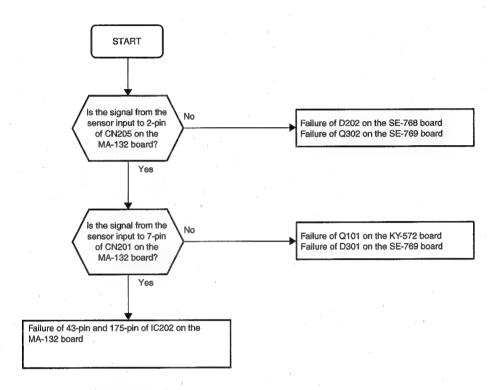
4-1. Print result is not satisfactory



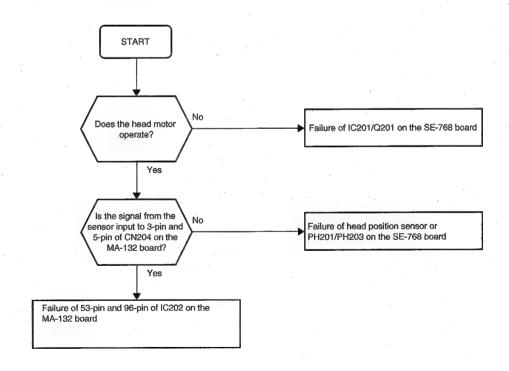
4-2. Print result density is too high or low



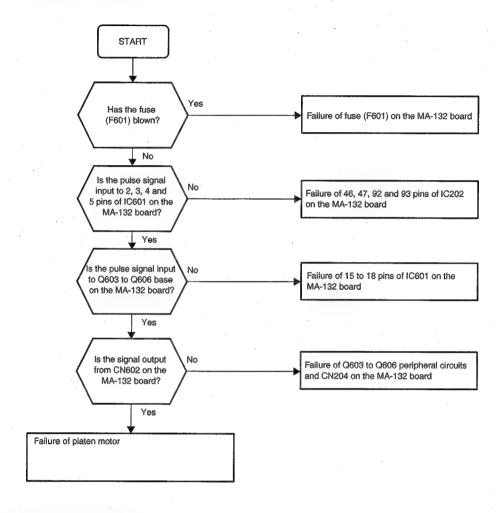
4-3. Trouble of determining presence or absence of paper



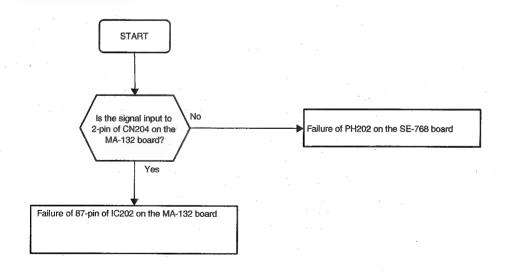
4-4. Thermal head UP/DOWN operation trouble



4-5. Feed operation trouble



4-6. Trouble of determining door open/close



Section 5 Service Mode (Self-diagnosis Function)

5-1. Startup Procedure

- 1. Turn on the power while pressing the COPY button and PRINT button.
- 2. Check that the backlight starts blinking after approximately 3 seconds, and then release each button. The service mode starts.

5-2. Service Mode Menu

When the unit is activated in service mode, the "SVC" menu is added one line above the "BEEP" menu. Press the jog dial in this "SVC" menu and rotate it up and down to display the item to be diagnosed, and then press it again. For the details of each item, refer to the following sections.

When the unit is activated in service mode, the time out function does not work. Therefore the unit does not exit the menu mode for approximately 20 seconds without any button operation.

```
READY \rightarrow SVC \rightarrow
                     PATAN
                                 Test pattern print (Refer to Section 5-3.)
                                 Test pattern print count (Refer to Section 5-4.)
                     SV.QTY
                                 LCD lighting test (Refer to Section 5-5.)
                     LCD
                     LIGHT
                                 LED lighting test (Refer to Section 5-6.)
                                 CONTR volume calibration (Refer to Section 5-7.)
                     CO:CAL
                                 BRIGHT volume calibration (Refer to Section 5-7.)
                     BR:CAL
                                 Switching of low-pass filter (Refer to Section 5-8.)
                     LPF
                     LOG
                                 Log print (Refer to Section 5-8.)
                     RESET
                                 Initialization of setting (Refer to Section 5-9.)
                                 Continuous switching of number of printed sheets (Refer to Section 5-11.)
                     QTY.C
                     RMCAP
                                 Capture timing of REMOTE (Refer to Section 5-12.)
                     TEMP
                                 Temperature indication (Refer to Section 5-10.)
                     TMODE
                                 Disabled even being switched
                                  Returns to SVC
            AGC
```

The usual menu continues.

5-3. Test Pattern Printing

Select the test pattern and press the jog dial to start the printing.

The preset number of test patterns are printed by setting the print count previously in "SV.QTY".

To interrupt the printing, press the FEED button or OPEN button.

When adjusting the head voltage, perform in the following conditions.

• Set "GAMMA" to "GA-2".

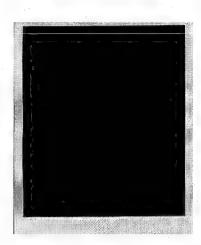
```
PATAN
           PA:FF
                     All white
                     Gray
           PA:00
                     All black
           PA:W/B White in the left half, black in the right half
           PA:B/W Black in the left half, white in the right half
                     All white (large size)
           PA:FFh
                     Gray (large size)
           PA:00h
                    All black (large size)
           PA:STP Stairstep
           PA:CRS Cross step
           BACK
                     Returns to PATAN
```



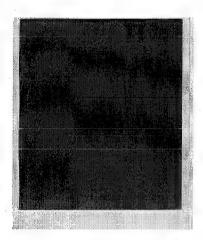
PA-CRS (cross step)



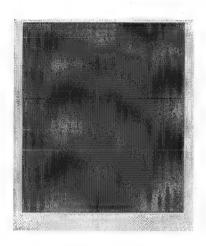
PA-STP (stairstep)



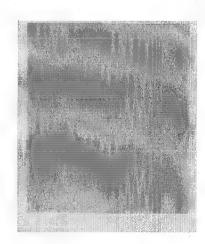
PA:00h



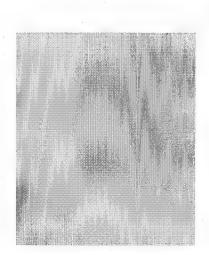
PA:3Fh



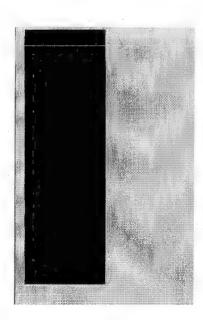
PA:7Fh



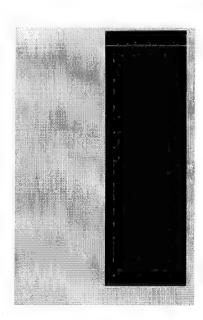
PA:BFh



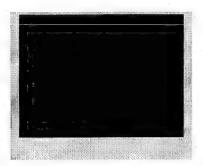
PA:FFh



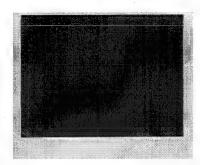
PA:B/W



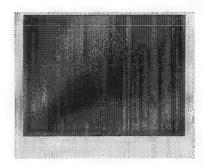
PA:W/B



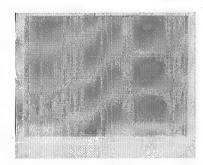
PA:00



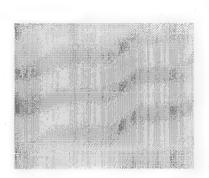
PA:3F



PA:7F



PA:BF



PA:FF

5-4. Test Pattern Print Count

Set the print count of the test pattern printing (PATAN).

SV.QTY SQ C

When setting the count to the

continuous printing.
S.Q 9 When setting the count to "9".

: S.Q:1

When setting the count to "1".

BACK

Returns to SV.QTY.

5-5. LCD Lighting Check

Check the portion that is not lit by fully lighting the LCD.

LCD (full lighting) Ch

Check if it is lit.

Returns to LCD when the jog dial is

pressed.

BACK

Returns to LCD.



LCD (full lighting)

5-6. LED Lighting Check

Check if the backlight of the LCD is lit.

LIGHT LI:RCV (LCD lights in green.)

LI:AMB Check if the backlight of the LCD

lights in amber.

LI:GRN Check if the backlight of the LCD

lights in green.

BACK Returns to LIGHT.

5-7. Front Panel Volume Calibration

Perform the calibration of the CONTR volume and BRIGHT volume. Perform this calibration when replacing the flexible flat cable connecting the KY-572 board or MA-132 board. Each volume is adjustable at three points: left, center and right.

CO:CAL CO:RIG Press the jog dial in the state that the CONTR volume is fully rotated to the right.

CO:CEN Press the jog dial in the state that the CONTR volume is at the center click position.

CO:LEF Press the jog dial in the state that the CONTR volume is fully rotated to the

BACK Returns to CO:CAL.

BR:CAL BR:RIG Press the jog dial in the state that the BRIGHT volume is fully rotated to the right.

BR:CEN Press the jog dial in the state that the BRIGHT volume is at the center click position.

BR:LEF Press the jog dial in the state that the BRIGHT volume is fully rotated to the left.

BACK Returns to BR:CAL.

5-8. Low-Pass Filter

The switching of a low-pass filter circuit in IC501 on the MA-132 board is set. The factory setting is "LP:OFF".

MA-132 board is set. The factory setting is "LP:OFF".

LP:ON When setting a low-pass filter to ON

LP:OFF When setting a low-pass filter to OFF

BACK Returns to LPF.

5-9. Log Printing

The print count or error log is printed. Set the printing paper in the paper tray.

LOG LO:OK The log is printed by pressing the jog dial.

BACK Returns to LOG.

T.PRN H.PRN T.ON F.ON H.TEMP 1.1501 2.1302 3.0000 4.0000 5.0000 6.0000 7.0000 8.0000	200 ② 100 ③ 10 ④ 10 ⑤ 30.7 ⑥ 20 0 0 0 0 0 0 0	29.4 27.9 0.0	7 7
--	---	---------------------	--------

1) Firmware version, date and time it is created

② T.PRN: Total print count

③ H.PRN: Head total print count

4 T.ON: Total power ON time (unit: hour)
 5 F.ON: Total fan ON time (unit: hour)

6 H.TEMP: Maximum head temperature (unit: °C)

The eight error logs can be saved.

1: The latest log, 8: The oldest log

From the left: Error ID, total print count at the time of error, head temperature at the time of error

Error ID

ID	Factor
1102h	Head cannot be moved from home position to printing position. (During printing)
1103h	Head cannot be moved from home position to printing position. (During feeding)
1105h	Head cannot be moved from home position to printing position. (During cleaning)
1204h	Head cannot be moved from home position to door open position. (During door open)
1301h	Head cannot be moved from printing position to home position. (During mechanical initialization)
1302h	Head cannot be moved from printing position to home position. (During printing)
1303h	Head cannot be moved from printing position to home position. (During feeding)
1305h	Head cannot be moved from printing position to home position. (During cleaning)
1401h	Head cannot be moved from door open position to home position. (During mechanical initialization)
1404h	Head cannot be moved from door open position to home position. (During door open)
1501h	Head cannot be moved from arbitrary position to any of the positions (printing/home/door open). (During mechanical initialization)
2100h	Thermistor is shorted. (Abnormally high temperature)
2200h	Head is not connected. (Abnormally low temperature)
2300h	Preheat time out
2400h	Cool down time out
3100h	Front paper sensor detects "no paper" during printing.
5100h	Print pulse time out
6101h	Prestart time out
6102h	Paper feed before printing time out

5-10. Initialization of Setting

RESET	R:ALL	Resets the unit to the factory
		setting.
	R:FAN	Resets the fan ON time.
		This is performed when replacing
		the fan.
	R.H.PRN	Resets the print count record to "0"
		This is performed when the head is
		replaced.
	R:MENU	Initializes the contents that are set
		in the menu.
	BACK	Returns to RESET.

5-11. Switching of Continuous Setting (C) in Number of Printed Sheets (QTY)

It is switched whether to display "QT.C" for continuous print setting in a "QTY" menu.

The factory setting is "Q.C:OFF".

QTY.C Q.C:ON When enabling the selection of continuous printing

Q.C:OFF When disabling the selection of continuous printing

BACK Returns to QTY.C.

5-12. Switching of REMOTE capture timing

The timing from when a PRINT signal is input to the REMOTE terminal on the front panel until it is captured is switched.

The factor setting is "RM:NOR".

RMCAP RM:JST Just mode

RM:NOR Normal mode

BACK Returns to RMCAP.

5-13. Temperature Indication

The current temperature data is displayed.

Example)

TEMP H.T:30.5

Head temperature: 30.5 °C

BACK

Returns to TEMP.

5-14. Switching of Toshiba Mode

It is switched whether to display Toshiba-dedicated view angles "SC:T1" and "SC:T2" in a "SCAN" menu. The contents of setting in a menu are reset during switching.

TMODE TM:ON

When enabling the selection of a

Toshiba-dedicated view angle

TM:OFF

When disabling the selection of a

Toshiba-dedicated view angle

BACK

Returns to TMODE.

5-15. FEED Operation

When the FEED button is pressed in the state that the paper tray is open, the stepping motor is activated and the platen rotates in the paper eject direction.

5-16. Menu Lock

This is the function to prohibit the change of the setting from the menu and disable the switching of the front volume. It is disabled only when the unit is started normally.

Lock/Release Procedure

Turn on the power while pressing the jog dial. After checking that a beep sound is made after approximately 3 seconds, release the button. When the lock is activated, "LOCK" is displayed on the LCD and when the lock is released, "UNLOK" is displayed on the LCD. If the jog dial or the front volume is operated when the lock is activated, a "beep" alarm sound is made and "LOCK" is displayed on the LCD.

Section 6 Spare Parts

6-1. Notes on Repair Parts

1. Safety Related Components Warning WARNING

Components marked \triangle are critical to safe operation. Therefore, specified parts should be used in the case of replacement.

2. Standardization of Parts

Some repair parts supplied by Sony differ from those used for the unit. These are because of parts commonality and improvement.

Parts list has the present standardized repair parts.

3. Stock of Parts

Parts marked with "o" at SP (Supply Code) column of the spare parts list may not be stocked. Therefore, the delivery date will be delayed.

4. Harness

Harnesses with no part number are not registered as spare parts.

In need of repair, get components shown in the list and repair using them.

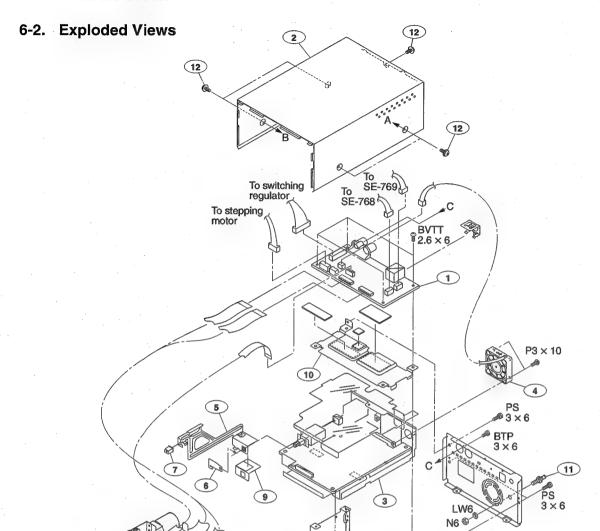
5. Symbol

Protective earth (ground)



To identify any terminal which is intended for connection to an external conductor for protection against electric shock in case of a fault, or the terminal of a protective earth (ground) electrode.

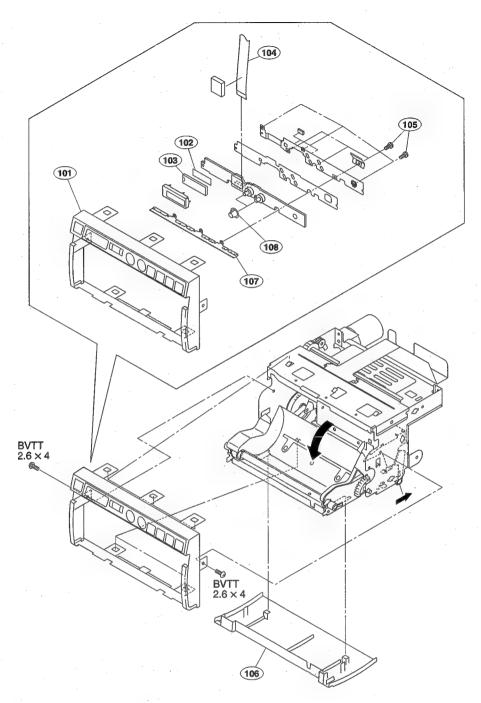
Cover and Chassis Block



No.	Part No. Si	P Description		No.	Part No.	SP Description
1 2 3	X-3698-532-3 a	MOUNTED CIRCUIT BOARD, SUB ASSY, TOP COVER REGULATOR, SWITCHING	MA-132 (A)	12	4-886-821-11	z SCREW, M3X6 CASE (SILVER)
4 5		s FAN, DC (40 SQUARE) s ROD, POWER SW				WASHER LW 6 (TYPE B) (for UC2/CED/SYN)
6		S STOPPER, SW ROD S BUTTON, POWER			7-682-647-09	s SCREW +P 3X10 (EP-FE/CU,NI,CR) s SCREW +PS 3X6(EP-FE/ZNBK/CM2) s NUT M6 TYPE2 (EP-FE/ZN/CM2)
- 8 9	3-857-734-01 s 3-857-736-01 s				7-685-546-14	(for UC2/CED/SYN) s SCREW +BTP 3X8
10		PLATE, SHIELD (ANALOG)				
11	3-990-273-01 \$	TERMINAL, P.E. (for UC2/CED/SYN)	•		7-685-862-09	s SCREW,+BVTT 2.6X6(EP-FE/ZNBK/CM2)

BVTT 2.6 × 6

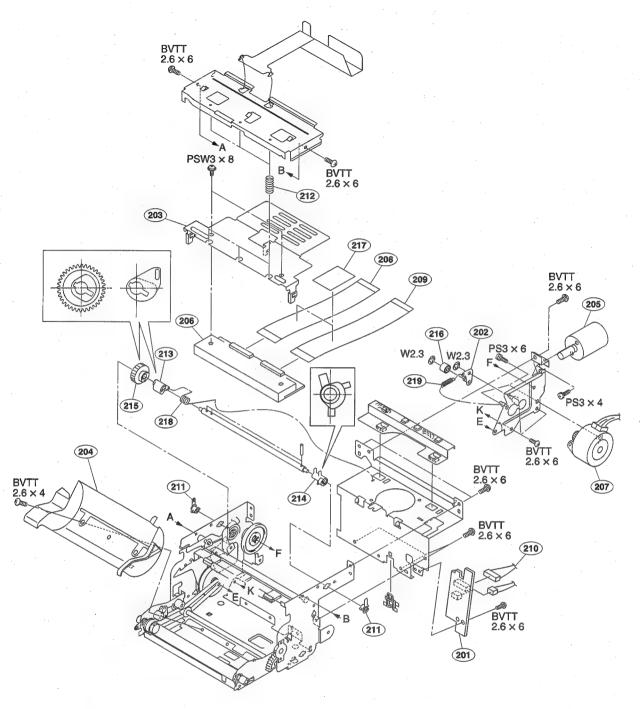
Front Panel Block



No.	Part No. SP	Description
101 102 103 104 105	1-780-223-11 s 1-805-786-11 s 1-831-138-11 s	FRONT PANEL ASSY(A) CONDUCTIVE BOARD, CONNECTION DISPLAY PANEL, LIQUID CRYSTAL CABLE, FLEXIBLE FLAT (24CORE) TAPPING SCREW M1.7
106 107 108	3-857-733-11 s 3-863-111-02 s 3-863-112-01 s	CUTTER

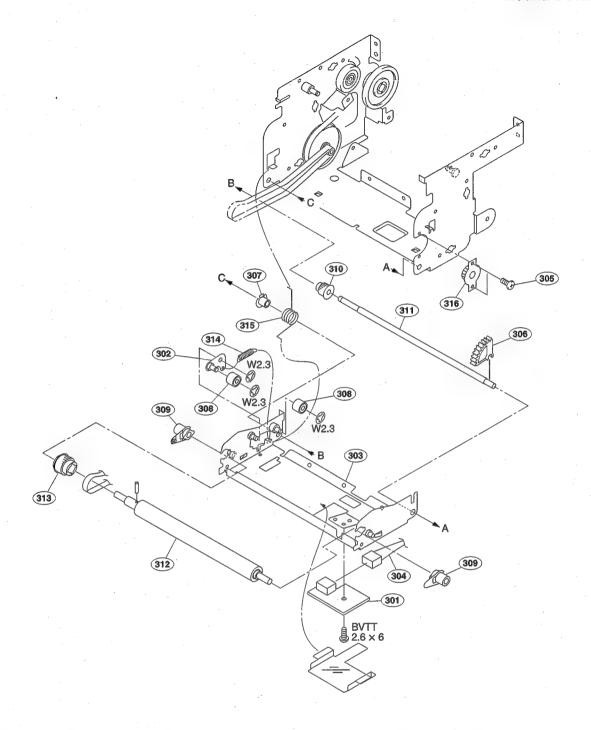
7-685-860-09 s SCREW, +BVTT 2.6X4 (EP-FE/ZNBK/CM2)

Mecha Deck Block 1



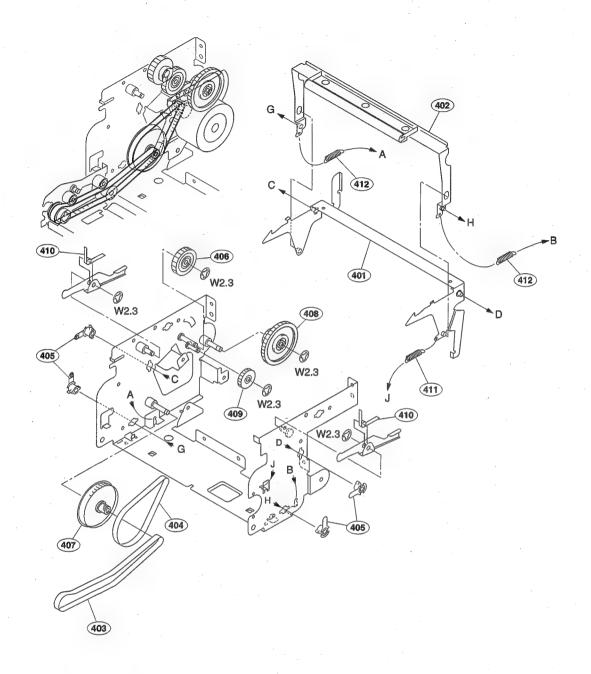
No.	Part No. SI	P Description	No.	Part No.	SP	Description
201	A-1078-892-A s	MOUNTED CIRCUIT BOARD, SE-768	213	3-857-753-03	3 s	CAM(L)
202	X-3608-983-1 E	SUB ASSY, TENSION ARM	214	3-857-754-03	3 s	CAM(R)
203	X-3608-987-3 E	ASSY, HEAT SINK	215	3-857-755-03	3 g	GEAR, CAM
204	X-3608-991-5 s	S ASSY, PAPER HOLDER				•
205	X-3704-803-1 s	S SUB ASSY, DC MOTOR (RP)	216	3-857-757-01	i s	ROLLER, TENSION
			217	3-857-783-04	l s	SUPPORT (FFC)
206	1-479-084-11 s	HEAD, THERMAL (LVE6426SS)	218	3-986-503-01	Ls	SPRING, TORSION
207	1-787-289-11 8	MOTOR, STEPPING	219	3-986-932-01	L.s	SPRING, MOTOR TENSION (1N)S
208	1-830-214-21 E	CABLE, FLEXIBLE FLAT (26 CORE)				
209	1-830-215-21 s	CABLE, FLEXIBLE FLAT (28 CORE)				
210	1-963-347-12 s	HARNESS, MA-SE768		3-669-596-00) s	WASHER, 2.3 (PLA)
		1		7-682-645-04	s	ISO SCREW+PS3X4 CR-N (13)
211	3-857-741-01 E	BEARING				SCREW +PS 3X6 (EP-FE/ZNBK/CM2)
212	3-857-749-01 s	SPRING, HEAD (10N)				SCREW +PSW 3X8

Mecha Deck Block 2



No.	Part No. S	P Description	No.	Part No.	SP	Description
301 302 303 304 305	X-3608-983-1 X-3608-984-1 1-963-348-12	s MOUNTED CIRCUIT BOARD, SE-769 s SUB ASSY, TENSION ARM s SUB ASSY, MD DOOR s HARNESS, MA-SE769 s SCREW (M2X4), LOCK ACE, P2	311 312 313 314 315	3-857-762-0 3-857-763-0 3-857-770-0	1 s 3 s 1 s	SHAFT, FULCRUM PLATEN PULLEY, PLATEN SPRING, DOOR EXTENSION (4N) SPRING, DOOR OPEN (C)
306 307 308 309 310	3-857-757-01 3-857-758-01	s GEAR, DUMPER s SPACER, FULCRUM s ROLLER, TENSION s BEARING, PLATEN s PULLEY, FULCRUM	316	3-669-596-0	0 s	DAMPER, OIL WASHER, 2.3 (PLA) SCREW, +BVTT 2.6X6 (EP-FE/ZNBK/CM2)

Mecha Deck Block 3



No.	Part No.	BP Description	No.	Part No. SP Description
403	X-3608-986-2 3-854-457-01	s SUB ASSY, DOOR LOCK s SUB ASSY, PINCH ARM s TIMING BELT (220TN10-5.0T) s TIMMING BELT (140TN10-4.0T)	411 412	3-986-931-01 s SPRING, LOCK(1.3N)S 3-990-805-01 s SPRING, PINCH(7.5N)
405	3-857-741-01			3-669-596-00 s WASHER,2.3 (PLA) 7-685-860-09 s SCREW,+BVTT 2.6X4(EP-FE/ZNBK/CM2)
406 407 408 409 410	3-857-746-02 3-857-750-03 3-857-751-03	s GEAR, IDLER s PULLEY, IDLER s WORM WHEEL s GEAR, REDUCTION (S) s LEAF SPRING (HEAD)		

6-6

6-3. Electrical Parts List

KY-572 (A) G BOARD	MA-132(A)G BOARD
Ref. No. or Q'ty Part No. SP Description	Ref. No. or Q'ty Part No. SP Description
C101 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B C102 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B	1pc A-1159-430-A s MOUNTED CIRCUIT BOARD, MA-132(A)G
C103 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V E C104 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V E	BZ201 1-544-886-11 s BUZZER, PIEZOELECTRIC
C105 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B C106 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B	C1 1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF C101 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C102 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C107 1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B C108 1-165-128-11 s CAPACITOR CERAMIC 0.22MF/16V F C109 1-165-128-11 s CAPACITOR CERAMIC 0.22MF/16V F	C103 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C104 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C110 1-165-128-11 s CAPACITOR CERAMIC 0.22MF/16V F CN101 1-817-368-61 s CONNECTOR, FFC/FPC (ZIF) 24P	C105 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C106 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C107 1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)
D101 6-501-137-01 s DIODE CL-375TD/SYG-D-TS	C108 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C110 1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)
EN101 1-477-089-31 s ENCODER (ROTARY)	C111 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C112 1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)
IC101 8-759-465-98 s IC BU9728AKV-E2	C113 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C114 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
Q102 6-550-988-01 B TRANSISTOR CPT-184S-C-TS-BCD	C115 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
R101 1-216-864-11 s CONDUCTOR, CHIP (1608) R105 1-216-853-11 s RESISTOR, CHIP 470K 1/16W(1608) R106 1-216-864-11 s CONDUCTOR, CHIP (1608)	C116 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C117 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C118 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
R107 1-216-864-11 s CONDUCTOR, CHIP (1608) R108 1-216-864-11 s CONDUCTOR, CHIP (1608)	C120 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C121 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
RV101 1-227-680-12 s RESISTOR, VAR, CARBON 10K RV102 1-227-680-12 s RESISTOR, VAR, CARBON 10K	C123 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V C124 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C127 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
\$101 1-771-884-31 s SWITCH, TACTILE \$102 1-771-884-31 s SWITCH, TACTILE \$103 1-771-884-31 s SWITCH, TACTILE	C128 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C129 1-125-837-91 s CAPACITOR, CHIP CERAMIC1MF/6.3V
\$104 1-771-884-31 s SWITCH, TACTILE VDR101 1-801-924-21 s VARISTOR, CHIP (1608)	C130 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C132 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C133 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
VDR102 1-801-924-21 s VARISTOR, CHIP (1608) VDR103 1-801-924-21 s VARISTOR, CHIP (1608)	C134 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C135 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
	C136 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C137 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C138 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C139 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C140 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
	C141 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C142 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C143 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C144 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C145 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
	C147 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C149 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C150 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C152 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C153 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
	C155 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C156 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C157 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C158 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C159 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF
	C160 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C161 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C162 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C163 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF C164 1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF

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(MA-132 (A) G BOARD)

Ref. No.		Ref. No.	
C166 C167 C168 C169	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C249 C250 C251 C252	Part No. SP Description 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V 1-165-870-21 s CAPACITOR, ELECT 100MF(6.3X6) 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V 1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C170 C171 C172 C173 C175 C176	1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012) 1-164-847-11 s CAPACITOR, CHIP CERAMIC 7PF/50V 1-164-847-11 s CAPACITOR, CHIP CERAMIC 7PF/50V 1-164-844-11 s CAPACITOR, CHIP CERAMIC 4PF/50V 1-125-889-11 s CAPACITOR, CERAMIC 2.2MF 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C253 C254 C255 C256 C257 C258	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF 1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V 1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C177	1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)	C259	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C178	1-164-844-11 s CAPACITOR, CHIP CERAMIC 4PF/50V	C260	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C179	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C261	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C180	1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF	C262	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C181	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C263	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C182	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C264	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C183	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C265	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C184	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C266	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C186	1-125-837-91 s CAPACITOR, CHIP CERAMIC1MF/6.3V	C267	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C187	1-165-872-21 s CAPACITOR, SOLID ELECT 47MF	C268	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C188	1-165-872-21 s CAPACITOR, SOLID ELECT 47MF	C269	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C201	1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)	C270	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C202	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C271	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C203	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C272	1-125-837-91 s CAPACITOR, CHIP CERAMIC1MF/6.3V
C204	1-164-943-11 s CAPACITOR, CHIP CERAMIC 0.01MF	C273	1-165-872-21 s CAPACITOR, SOLID ELECT 47MF
C205	1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)	C274	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C206	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C275	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C207	1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)	C276	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C208	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C277	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C209	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C278	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C210	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C279	1-164-858-11 s CAPACITOR, CERAMIC 22PF/50V
C211	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C280	1-164-858-11 s CAPACITOR, CERAMIC 22PF/50V
C212	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C281	1-164-858-11 s CAPACITOR, CERAMIC 22PF/50V
C213	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C282	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C214	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C283	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C215	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C284	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C216	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C285	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C217	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C286	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C218	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C287	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C219	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C288	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C220	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C289	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C223	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C290	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C224	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C291	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C225	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C292	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C226	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C293	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C227	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF	C294	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C231	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C295	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C232	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C296	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C233	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C297	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C235	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C298	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C237	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C299	1-164-866-11 s CAPACITOR, CHIP CERAMIC 47PF/50
C238	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C300	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V
C239	1-125-891-11 s CAPACITOR CERAMIC 0.47MF/10V	C301	1-165-870-21 s CAPACITOR, ELECT 100MF(6.3X6)
C240	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C302	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF
C241	1-125-891-11 s CAPACITOR CERAMIC 0.47MF/10V	C303	1-127-715-11 s CAPACITOR, CERAMIC 0.22MF B1608
C245	1-165-989-11 s CAPACITOR, CERAMIC 10MF (2012)	C304	1-127-715-11 s CAPACITOR, CERAMIC 0.22MF B1608
C246	1-125-777-11 s CAPACITOR CERAMIC 0.1MF/10V	C305	1-127-715-11 s CAPACITOR, CERAMIC 0.22MF B1608
C247	1-125-837-91 s CAPACITOR, CHIP CERAMIC1MF/6.3V	C308	1-115-339-11 s CAPACITOR, CERAMIC 0.1MF/50V
C248	1-107-826-11 s CAPACITOR, CHIP CERAMIC 0.1MF	C309	1-100-276-21 s CAP, ELECT 22MF (5.0X6.5)

FB102

1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B

C541

C542

(MA-132 (A) G BOARD)

Ref. No.	Ref. No.
or Q'ty Part No. SP Description	or Q'ty Part No. SP Description
FB103 1-414-813-11 s MICRO INDUCTOR(CHIP TYPE) 2012 FB104 1-414-813-11 m MICRO INDUCTOR(CHIP TYPE) 2012 FB105 1-414-813-11 m MICRO INDUCTOR(CHIP TYPE) 2012 FB201 1-414-813-11 s MICRO INDUCTOR(CHIP TYPE) 2012 FB202 1-414-813-11 s MICRO INDUCTOR(CHIP TYPE) 2012	IC501 8-753-218-19 E IC CXA2169Q-T4 IC502 8-752-371-18 E IC CXD2302Q IC503 6-803-271-01 S IC SN74LVCLG04DCKR IC504 8-759-337-40 S IC NJM2904V(TE2) IC509 8-759-287-50 S IC CXD8932Q
FB203 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB204 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB205 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB206 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB207 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	IC510 6-705-771-01 s IC SN74LVC1G32DCKR IC511 6-705-771-01 s IC SN74LVC1G32DCKR IC512 8-759-297-58 s IC DS1000Z-50 IC513 8-759-649-33 s IC SN74AHCT1G08DCKR IC601 8-759-549-20 s IC SN74LV541APWR
FB208 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB209 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB210 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	JC103 1-216-864-11 s CONDUCTOR, CHIP (1608) JC201 1-216-864-11 s CONDUCTOR, CHIP (1608)
FB211 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB212 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB213 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB214 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	L103 1-410-381-11 s INDUCTOR, CHIP 10UH (3225) L104 1-410-381-11 s INDUCTOR, CHIP 10UH (3225) L301 1-424-653-11 s COIL, CHOKE 10UH L305 1-469-828-11 s INDUCTOR 100UH L306 1-424-653-11 s COIL, CHOKE 10UH
FB215 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB216 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB217 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	L307 1-424-653-11 & COIL, CHOKE 10UH
FB218 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	Q101 8-729-901-00 S TRANSISTOR DTC124EK Q102 8-729-028-73 S TRANSISTOR DTA114EUA-T106 Q103 8-729-120-28 S TRANSISTOR 2SC1623-L5L6 Q104 8-729-901-00 S TRANSISTOR DTC124EK Q203 8-729-928-81 S TRANSISTOR DTC144EE
FB224 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	Q204 8-729-928-90 s TRANSISTOR DTC114EE Q205 8-729-928-90 s TRANSISTOR DTC114EE Q206 6-550-139-01 s TRANSISTOR IMZ1A-T108 Q208 8-729-928-81 s TRANSISTOR DTC144EE Q210 8-729-928-81 s TRANSISTOR DTC144EE
FB252 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB253 1-414-813-11 s MICRO INDUCTOR(CHIP TYPE) 2012 FB254 1-414-813-11 s MICRO INDUCTOR(CHIP TYPE) 2012 FB255 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB256 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE)	Q211 8-729-928-81 s TRANSISTOR DTC144EE Q301 6-550-139-01 s TRANSISTOR IMZ1A-T108 Q302 8-729-053-92 s TRANSISTOR 2SB1424-T100-QR Q401 8-729-928-90 s TRANSISTOR DTC114EE Q402 8-729-230-27 s TRANSISTOR 2SA1213Y-TE12L
FB257 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB501 1-414-760-21 s INDUCTOR, MICRO (CHIP TYPE) FB502 1-216-864-11 s CONDUCTOR, CHIP (1608) FB503 1-216-864-11 s CONDUCTOR, CHIP (1608)	Q501 8-729-928-90 s TRANSISTOR DTC114EE Q502 8-729-927-99 s TRANSISTOR 2SC4617R Q503 8-729-901-00 s TRANSISTOR DTC124EK Q504 8-729-901-00 s TRANSISTOR DTC124EK Q601 8-729-140-75 s TRANSISTOR 2SD999-CLOCK
IC101 6-708-493-01 s IC HY57V281620ETP-HDR IC102 6-708-493-01 s IC HY57V281620ETP-HDR IC105 6-702-688-01 s IC M24C64-WMN6T(B) IC106 8-759-649-45 o IC SN74AHC1604DCKR IC107 6-705-771-01 s IC SN74LVC1G32DCKR	Q602 8-729-017-80 s TRANSISTOR 2SD992-Z Q603 8-729-017-80 s TRANSISTOR 2SD992-Z Q604 8-729-017-80 s TRANSISTOR 2SD992-Z Q605 8-729-017-80 s TRANSISTOR 2SD992-Z Q606 8-729-017-80 s TRANSISTOR 2SD992-Z
IC109 6-706-712-01 s IC BD45401G IC110 6-703-671-01 o IC BR9040F-WE2 IC201 6-705-868-01 s IC XC2173S01XMR	Q607 8-729-140-75 s TRANSISTOR 2SD999-CLOCK Q608 8-729-017-80 m TRANSISTOR 2SD992-Z
IC203 6-705-771-01 s IC SN74LVC1G32DCKR IC204 8-759-549-23 s IC SN74LV74APWR	R1 1-218-863-11 s RESISTOR, CHIP 4.7K 1/10W(1608) R2 1-218-847-11 s RESISTOR, CHIP 1K 1/10W(1608) R3 1-218-855-11 s RESISTOR, CHIP 2.2K 1/10W(1608)
IC205 8-759-277-63 s IC TC7W14FU (TE12R) IC206 8-759-337-40 s IC NJM2904V(TE2) IC207 8-759-669-48 s IC LM324PWR-12	R4 1-218-859-11 s RESISTOR, CHIP 3.3K 1/10W(1608) R5 1-218-863-11 s RESISTOR, CHIP 4.7K 1/10W(1608)
IC208 8-759-564-49 s IC TC7W53FU-TE12R IC209 6-706-704-01 s IC TLV3402IDGKR	R6 1-218-855-11 s RESISTOR, CHIP 2.2K 1/10W(1608) R7 1-218-859-11 s RESISTOR, CHIP 3.3K 1/10W(1608) R8 1-218-847-11 s RESISTOR, CHIP 1K 1/10W (1608)
IC301 6-700-394-01 s IC BA25BC0FP-TE2 IC302 6-706-191-01 s IC BD9701FP-E2 IC303 6-700-792-01 s IC NJM78M09DL1A(TE1) IC304 6-705-879-01 s IC XC62EP1602MR IC305 8-759-234-08 s IC TA78L05F	R101 1-218-965-11 s RESISTOR, CHIP 10K 1/16W R102 1-218-965-11 s RESISTOR, CHIP 10K 1/16W

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UP-897MD

(MA-132(A)G BOARD)

Ref. No.	Part No. SP Description	Ref. No or Q'ty	Part No. SP Description
R264	1-216-864-11 s CONDUCTOR, CHIP (1608)	R537	1-216-801-11 s RESISTOR, CHIP 22 1/10W (1608)
R266	1-216-864-11 s CONDUCTOR, CHIP (1608)	R539	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R268	1-216-864-11 s CONDUCTOR, CHIP (1608)	R540	1-216-864-11 s CONDUCTOR, CHIP (1608)
R273	1-216-864-11 s CONDUCTOR, CHIP (1608)	R541	1-216-864-11 s CONDUCTOR, CHIP (1608)
R274	1-218-887-11 s RESISTOR, CHIP 47K 1/10W (1608)	R542	1-218-937-11 s RESISTOR, CHIP 47
R275	1-216-864-11 s CONDUCTOR, CHIP (1608)	R543	1-218-937-11 s RESISTOR, CHIP 47
R278	1-218-965-11 = RESISTOR, CHIP 10K 1/16W	R544	1-218-937-11 s RESISTOR, CHIP 47
R279	1-208-643-11 s RESISTOR CHIP 22 1/16W (1005)	R545	1-218-937-11 s RESISTOR, CHIP 47
R281	1-216-864-11 s CONDUCTOR, CHIP (1608)	R546	1-218-937-11 s RESISTOR, CHIP 47
R282	1-216-864-11 s CONDUCTOR, CHIP (1608)	R547	1-218-937-11 s RESISTOR, CHIP 47
R284 R302 R305 R307 R308	1-216-821-11 s RESISTOR, CHIP 1.0K 1/10W(1608) 1-216-829-11 s RESISTOR, CHIP 4.7K 1/10W(1608)	R548 R549 R562 R563 R564	1-218-937-11 s RESISTOR, CHIP 47 1-218-937-11 s RESISTOR, CHIP 47 1-216-829-11 s RESISTOR, CHIP 4.7K 1/10W(1608) 1-216-829-11 s RESISTOR, CHIP 4.7K 1/10W(1608) 1-216-857-11 s RESISTOR, CHIP 1M 1/10W(1608)
R309	1-242-967-11 s RESISTOR, CHIP 1.0 (1005)	R565	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R310	1-242-967-11 s RESISTOR, CHIP 1.0 (1005)	R566	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R311	1-218-941-81 s RESISTOR, CHIP 100,1/16W (1005)	R567	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R312	1-242-967-11 s RESISTOR, CHIP 1.0 (1005)	R573	1-216-864-11 s CONDUCTOR, CHIP (1608)
R313	1-242-967-11 s RESISTOR, CHIP 1.0 (1005)	R575	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R314	1-218-869-11 s RESISTOR, CHIP 8.2K 1/10W(1608)	R578	1-216-864-11 s CONDUCTOR, CHIP (1608)
R315		R582	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R318		R583	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R319		R584	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R320		R601	1-216-821-11 s RESISTOR, CHIP 1.0K 1/10W(1608)
R321	1-242-967-11 s RESISTOR, CHIP 1.0 (1005)	R602	1-216-825-11 = RESISTOR, CHIP 2.2K 1/10W 1608
R415	1-208-699-11 s RESISTOR, CHIP 4.7K 1/16W(1005)	R603	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R417	1-208-855-81 s RESISTOR, CHIP 47 1/16W (1005)	R604	1-216-818-11 = RESISTOR, CHIP 560 1/10W 1608
R418	1-216-817-11 s RESISTOR, CHIP 470 1/10W 1608	R605	1-216-809-11 = RESISTOR, CHIP 100 1/10W 1608
R419	1-208-927-11 s RESISTOR, CHIP 47K 1/16W(1005)	R606	1-216-818-11 = RESISTOR, CHIP 560 1/10W 1608
R501	1-216-864-11 s CONDUCTOR, CHIP (1608)	R607	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R503	1-216-864-11 s CONDUCTOR, CHIP (1608)	R608	1-216-818-11 s RESISTOR, CHIP 560 1/10W 1608
R504	1-216-811-11 s RESISTOR, CHIP 150 1/10W(1608)	R609	1-216-818-11 s RESISTOR, CHIP 560 1/10W 1608
R505	1-216-811-11 s RESISTOR, CHIP 150 1/10W(1608)	R610	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R506	1-218-879-11 s RESISTOR, CHIP 22K 1/10W (1608)	R611	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608
R507	1-218-871-11 s RESISTOR, CHIP 10K 1/10W (1608)	R612	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R508	1-216-845-11 s RESISTOR, CHIP 100K 1/10W (1608)	R613	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R509	1-216-811-11 s RESISTOR, CHIP 150 1/10W (1608)	R614	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R510	1-216-811-11 s RESISTOR, CHIP 150 1/10W (1608)	R615	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R511	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608	R616	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R512	1-216-821-11 s RESISTOR, CHIP 1.0K 1/10W (1608)	R617	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R513	1-218-871-11 s RESISTOR, CHIP 10K 1/10W (1608)	R618	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R515	1-216-821-11 s RESISTOR, CHIP 1.0K 1/10W (1608)	R619	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R516	1-216-821-11 s RESISTOR, CHIP 1.0K 1/10W (1608)	R620	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R517	1-218-871-11 s RESISTOR, CHIP 10K 1/10W (1608)	R621	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R518	1-218-869-11 s RESISTOR, CHIP 8.2K 1/10W(1608)	R622	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R519	1-218-863-11 s RESISTOR, CHIP 4.7K 1/10W(1608)	R623	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R520	1-218-837-11 s RESISTOR, CHIP 390 1/10W (1608)	R624	1-216-841-11 s RESISTOR, CHIP 47K 1/10W 1608
R521	1-216-864-11 s CONDUCTOR, CHIP (1608)	R625	1-216-825-11 s RESISTOR, CHIP 2.2K 1/10W 1608
R523	1-216-864-11 s CONDUCTOR, CHIP (1608)	R626	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R524	1-216-857-11 s RESISTOR, CHIP 1M 1/10W(1608)	R627	1-216-821-11 s RESISTOR, CHIP 1.0K 1/10W(1608)
R525	1-216-834-11 s RESISTOR, CHIP 12K 1/16W 1608	R628	1-216-833-11 s RESISTOR, CHIP 10K 1/10W (1608)
R526	1-216-864-11 s CONDUCTOR, CHIP (1608)	R2000	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608
R527	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608	R2001	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608
R528	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608	R2002	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608
R529	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608	R2003	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608
R530	1-216-809-11 s RESISTOR, CHIP 100 1/10W 1608	R2004	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608
R533	1-218-841-11 s RESISTOR, CHIP 560 1/10W (1608)	R2005	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608
R534	1-218-837-11 s RESISTOR, CHIP 390 1/10W (1608)	R2006	1-216-805-11 s RESISTOR, CHIP 47 1/10W 1608

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X101

X102

X500

1-795-613-11 s VIBRATOR, CRYSTAL (27MHZ)

1-813-213-21 s VIBRATOR, CERAMIC

1-795-949-11 s VIBRATOR, CRYSTAL

6-4. Supplied Accessories

SE-769 BOARD

Ref. No.

or Q'ty Part No. SP Description

A-1078-894-A s MOUNTED CIRCUIT BOARD, SE-769 1pc

1-162-970-11 s CAPACITOR CERAMIC 0.01MF/25V B C301 1-162-970-11 B CAPACITOR CERAMIC 0.01MF/25V B C302

1-774-730-21 s PIN, CONNECTOR (PC BOARD) 3P CN301

6-501-381-01 s DIODE CL-2011R-X-TSL-BC D301

6-550-794-01 s TRANSISTOR CPT-184S-C-TU-BCD Q302

1-216-864-11 s CONDUCTOR, CHIP (1608) 1-216-864-11 s CONDUCTOR, CHIP (1608) R301 R302

1-218-845-11 s RESISTOR, CHIP 820 1/10W (1608) R303

VDR301 1-801-924-21 s VARISTOR, CHIP (1608)

SU-112 BOARD

Ref. No.

SP Description or Q'ty Part No.

1-164-227-11 s CAPACITOR, CERAMIC 0.022MF/25V C401

1-580-055-21 o PIN, CONNECTOR 2P CN401

SUPPLIED ACCESSORIES

*1: [UP-897MD(UC2)]

*2: [UP-897MD(CED)] *3: [UP-897MD(UC2/CED)]

Ref. No.

or Q'ty Part No. SP Description

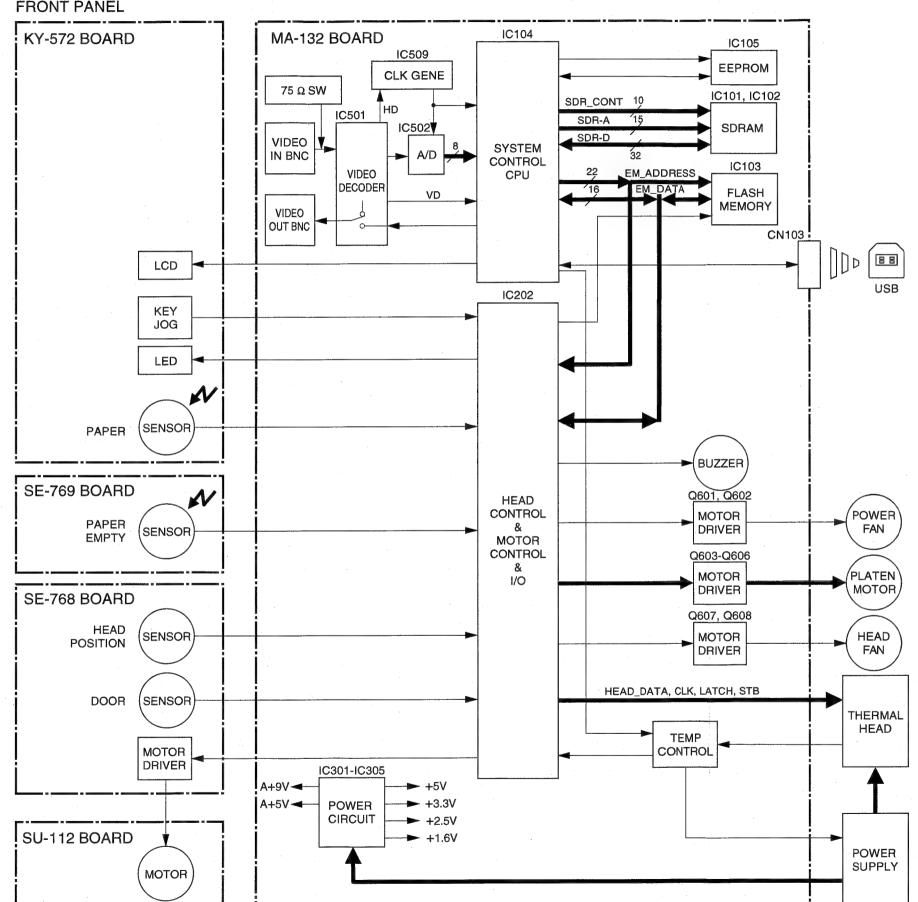
1pc *3 1-551-475-31 s 3C2V 1.5M CABLE 1pc \triangle *2 1-551-631-00 s POWER-SUPPLY CORD (IEC) 1pc \triangle *1 1-556-813-22 s CORD, POWER

1pc

2-345-262-11 s INSTRUCTIONS FOR USE 3-623-865-01 s SHEET, HEAD CLEANING (ACLYLIC) 1pc

Section 7 **Block Diagram**





Section 8 Schematic Diagrams

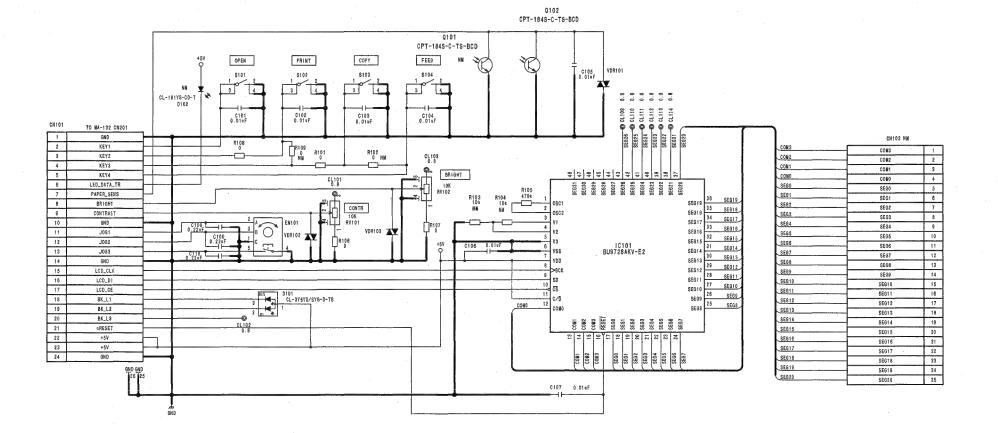
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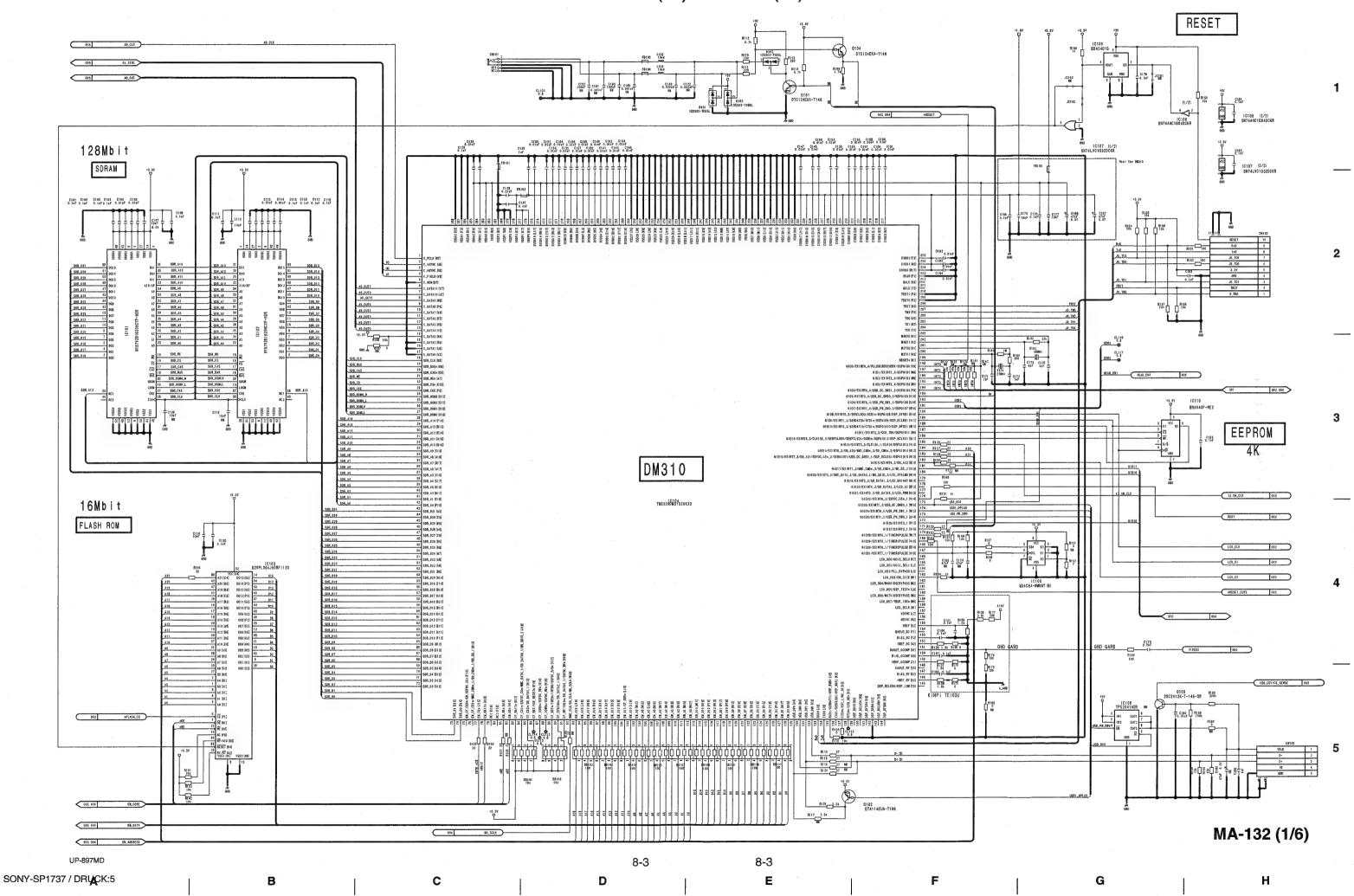


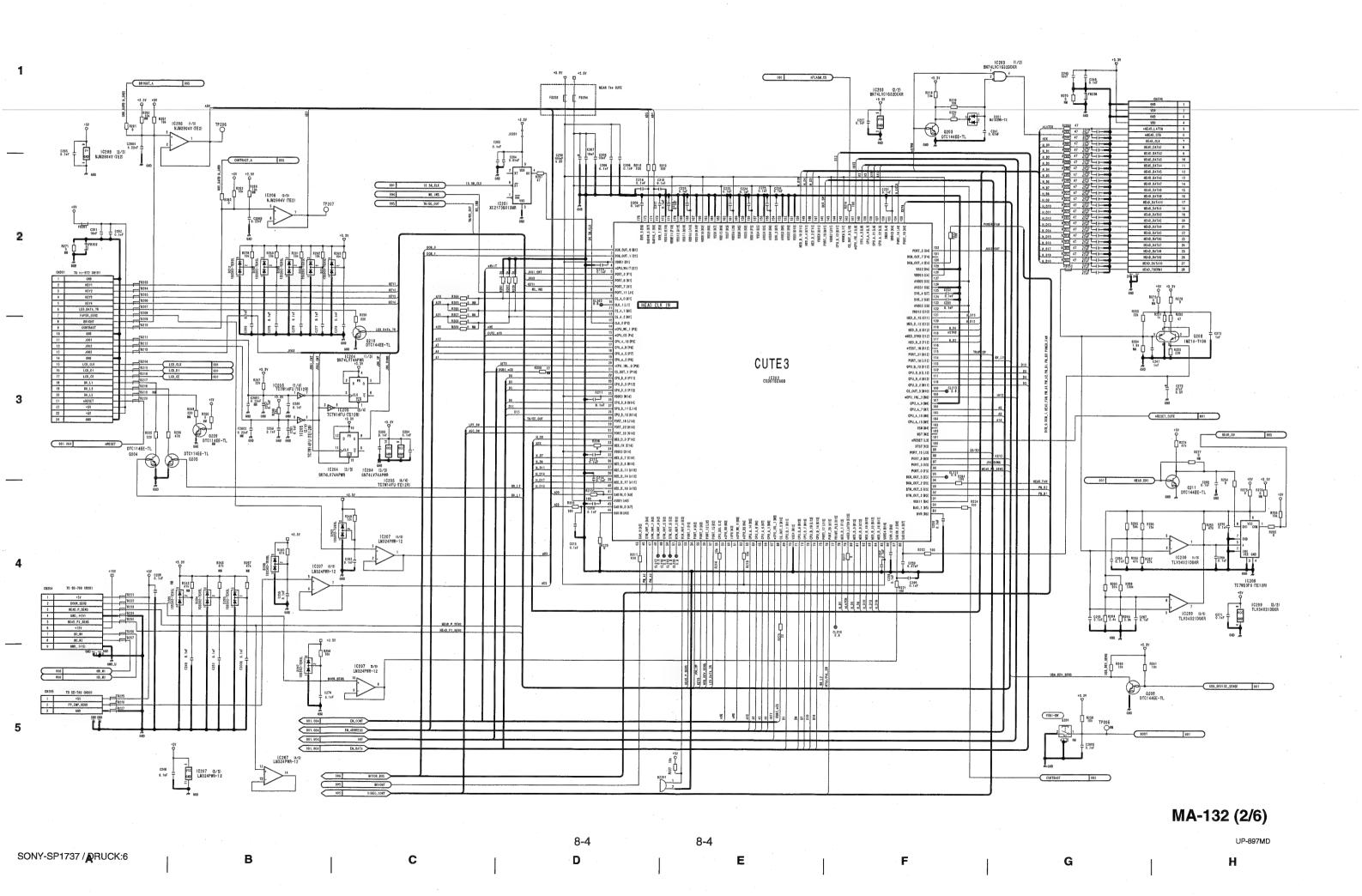
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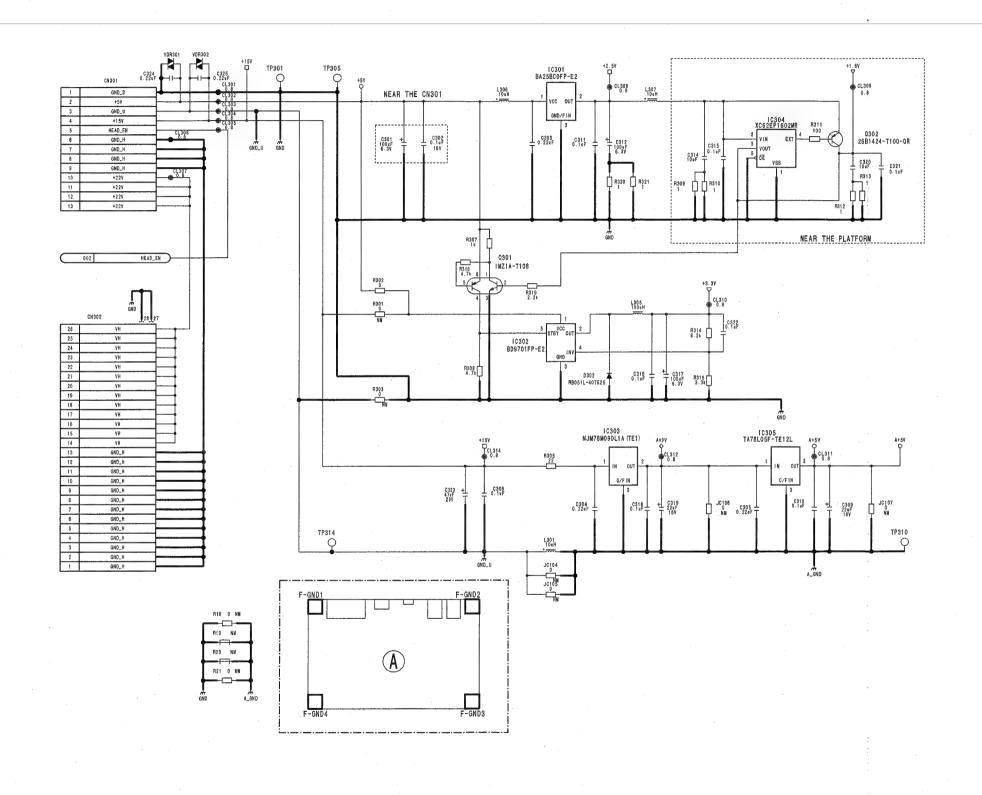
UP-897MD

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SONY-SP1737 / PRUCK:4







MA-132 (3/6)

UP-897MD SONY-SP1737 / DRUCK:7

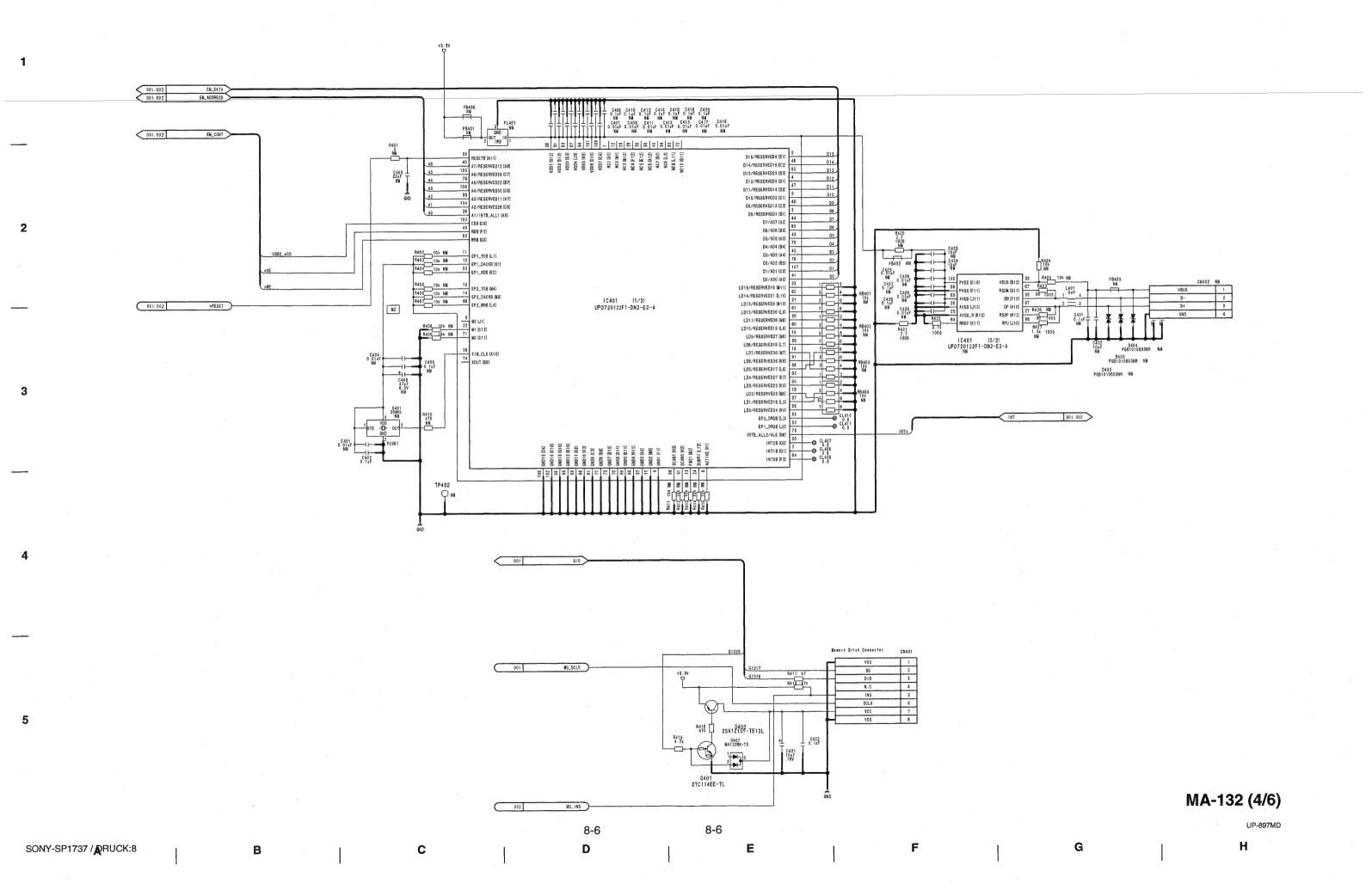
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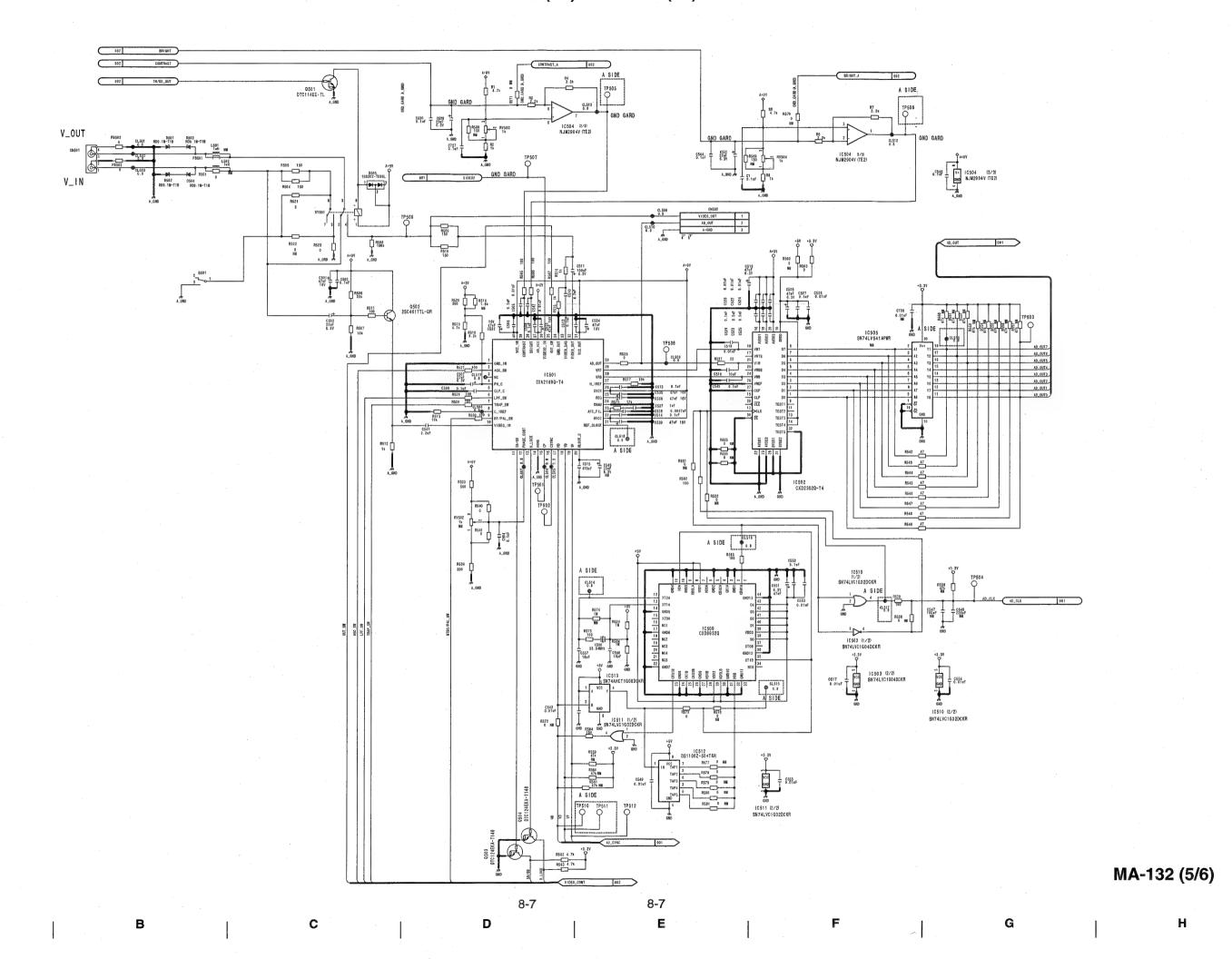
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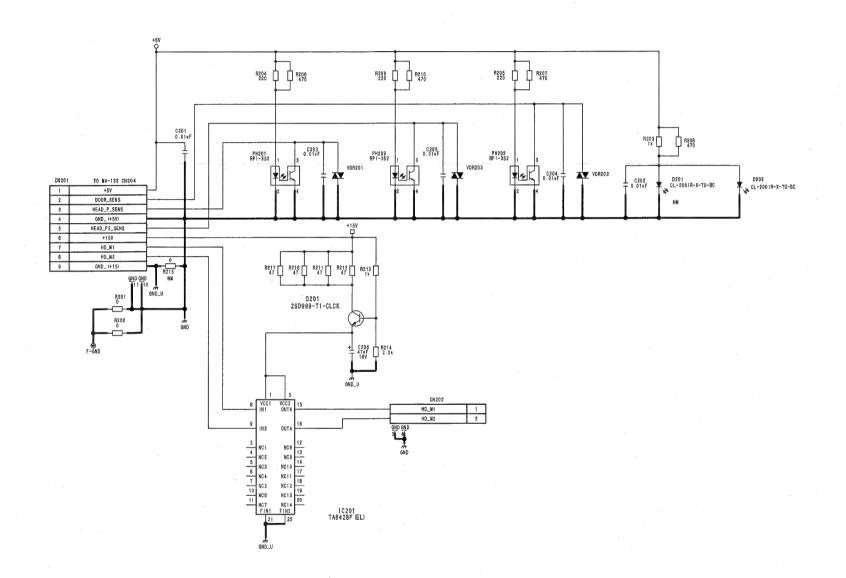
SONY-SP1737 / DRUCK:9

F400/125V/1.25A PATTERN WIDETH =1.5mm R609 560 R625 2 R602 Q607 2SD999-T1-CLCK Q601 2SD999-T1-CLCK Q605 2SD992-Z-E2 CN603 HEAD_FAN+ HEAD_FAN-2SD992-Z-E2 PATTERN WIDETH =1.5mm
PATTERN WIDETH =1.5mm
PATTERN WIDETH =1.5mm
PATTERN WIDETH =1.5mm MOTOR_BUS 002 R627 PLACE OUT OF THE BLOCK | R605 R607 R610 R611 R628 R613 R616 . R817 | R618 | R619 | R620 | R621 | R622 | R623 | R624 | 47k | PM_A1 PM_B2 PM_A2 PM_B1 POWER_FAN
HEAD_FAN
DCM_0
DCM_1 HD_M1 --

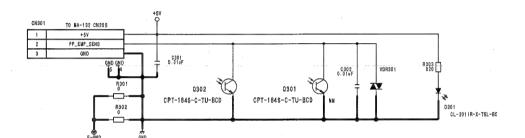
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SONY-SP1737/APRUCK:10 B C D E F G H



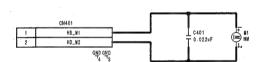
SE-768



SE-769

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SU-112

UP-897MD SONY-SP1737 / DRUCK:11

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1 KEY1
KEY2
KEY3
KEY4
LED_DATA_TR
PAPER_SENS
BRIGHT
CONTRAST
GND
JOG1
JOG2
JOG3
GND KY-572 LCD_CLK LCD_DI
LCD_CE
BK_L1
BK_L2
BK_L3
sRESET
+5V
+5V +5V PP_EMP_SENS GND SE-769 PP_EMP_SENS GND CN2010 CN201
1 2 DOOR
3 HEAD
4 GND
5 HEAD
6 +
7 HI
8 NI
9 GND DOOR_SENS HEAD_P_SENS SE-768 GND_ (+5V) HEAD_P2_SENS HEAD_P2_SENS 3 11,112, CN102

RESET

RED

TxD

JD_TCK

JD_TDO

3.3Y CN202 2 2 USB (Full) CN103 CN103 CN401 SU-112 DC MOTOR 5 8-10 8-10

SONY-SP1737 / PRUCK:12

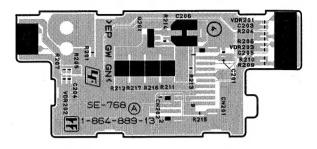
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UP-897MD Н

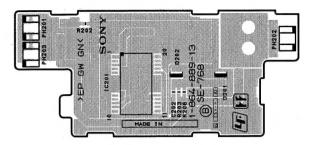
Section 9 **Board Layouts**

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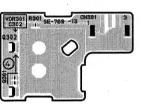
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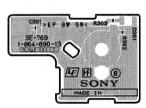
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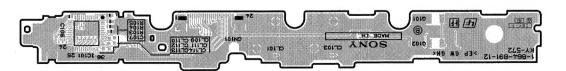
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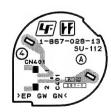
SE-769 -A SIDE-SUFFIX: -13



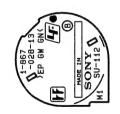
SE-769 -B SIDE-SUFFIX: -13



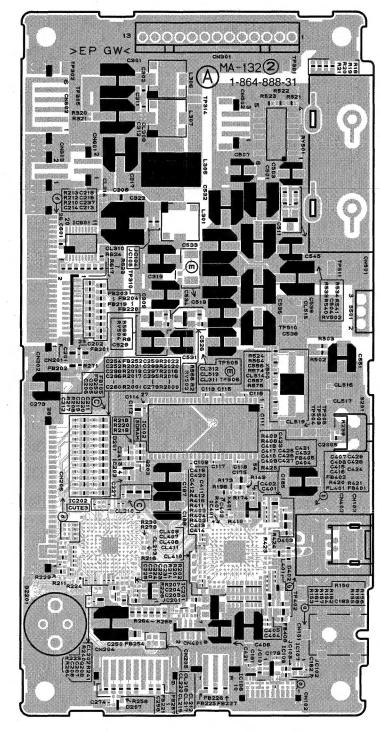
KY-572 -B SIDE-SUFFIX: -12



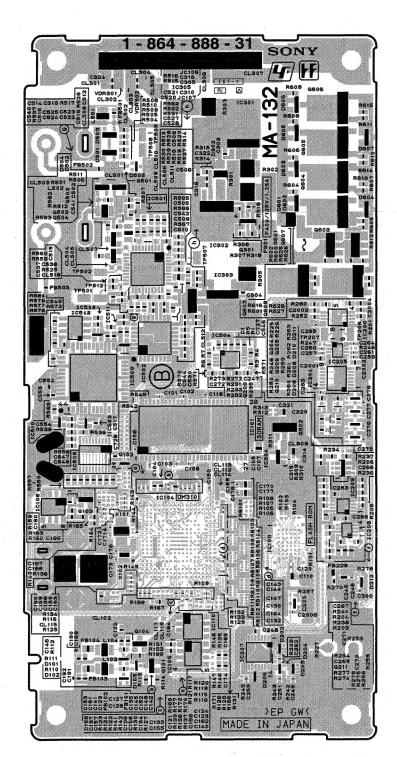
SU-112 -A SIDE-SUFFIX: -13



SU-112 -B SIDE-SUFFIX: -13



MA-132 -A SIDE-SUFFIX: -31



MA-132 -B SIDE-SUFFIX: -31

SAFETY CHECK-OUT

After correcting the original service problem, perform the following safety checks before releasing the set to the customer:

Check the metal trim, "metallized" knobs, screws, and all other exposed metal parts for AC leakage. Check leakage as described below.

LEAKAGE TEST

The AC leakage from any exposed metal part to earth ground and from all exposed metal parts to any exposed metal part having a return to chassis, must not exceed 0.5 mA. Leakage current can be measured by any one of three methods.

- A commercial leakage tester, such as the Simpson 229 or RCA WT-540A. Follow the manufacturers' instructions to use these instruments.
- 2. A battery-operated AC milliammeter. The Data Precision 245 digital multimeter is suitable for this job.
- 3. Measuring the voltage drop across a resistor by means of a VOM or battery-operated AC voltmeter. The "limit" indication is 0.5 V, so analog meters must have an accurate low-voltage scale. The Simpson 250 and Sanwa SH-63Trd are examples of a passive VOM that is suitable. (See Fig. A)

